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1 **Effect of Mold Corner Shape on the Initial Solidification Behavior of Molten Steel**
2 **by Using Mold Simulator**

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11
12 **Abstract:**

13 The chamfered mold with a typical corner shape (angle between the chamfered face
14 and hot face is 45 degree) was applied to the mold simulator study in this paper, and the
15 results were compared with the previous results from a well-developed right-angle mold
16 simulator system. The results suggested that the designed chamfered structure would
17 increase the thermal resistance and weaken the two-dimensional heat transfer around the
18 mold corner, causing the homogeneity of the mold surface temperatures and heat fluxes.
19 In addition, the chamfered structure can decrease the fluctuation of the steel level and the
20 liquid slag flow around the meniscus at mold corner. The cooling intensities at different
21 longitudinal sections of shell are close to each other due to the similar time-average
22 solidification factors, which are 2.392 mm/s^{1/2} (section A-A: chamfered center), 2.372
23 mm/s^{1/2} (section B-B: 135° corner) and 2.380 mm/s^{1/2} (section D-D: face), respectively.
24 For the same oscillation mark (OM), the heights of OM roots at different positions
25 (profile L1(face), profile L2(135° corner) and profile L3(chamfered center)) are very
26 close to each other. The average value of height difference (H_D) between two OM roots
27 for L1 and L2 is 0.22 mm, and for L2 and L3 is 0.38 mm. Finally, with the help of
28 metallographic examination, the shapes of different hooks were also discussed.

29 **I. INTRODUCTION**

30 Surface defects, such as longitudinal or transverse cracks, longitudinal off-corner
31 depressions, and deep oscillation marks (OMs), have widely existed in the continuous
32 casting strands.^[1] Many surfaces defects originate from the initial solidification of molten
33 steel inside the mold.^[2,3] If the surface defects could not be removed by scarfing or

34 grinding prior to the rolling process, some detrimental defects such as slivers and blisters
35 would occur on the final rolled products.^[4-7] Therefore, the elimination of surface defects
36 is crucial for improving the quality of final continuous casting products.

37 Many works related to the meniscus phenomena (such as heat transfer, fluid flow
38 and interaction of forces), which affect the initial solidification and the formation of OMs,
39 have been done to understand the formation mechanism of surface defects.^[8,9] Tomono^[10]
40 and Ackerman^[11] proposed the overflowing and folding mechanism for the formation of
41 OMs through the observations on the scaled caster by using organic compounds and steel.
42 Based on the industrial measurements and observations combined with the mathematical
43 modeling, Thomas et al.^[12] proposed a detailed mechanism for the formation of hooks
44 and their associated OMs. Lopez et al.^[13] built a mathematical model for the metal-slag
45 flow coupled with the heat transfer and solidification to study the influence of slag
46 infiltration on the shell solidification and the formation of the OMs. Brimacombe et al.^[1,14]
47 conducted the study to elucidate the relation between the mold hot-face temperatures at
48 the meniscus, slag thickness, and the OM depth. Matsushita et al.^[15] have directly
49 observed the meniscus of molten steel in the mold through a quartz glass window
50 mounted in the mold wall, to investigate the relationship between the surface wave
51 motion of molten steel and the mold oscillation. Furthermore, the dip-type mold
52 simulator was also applied to study the meniscus phenomena by many researchers,^[16-20]
53 and their results showed that the dip-type mold simulator could provide an ideal way for
54 the study of initial solidification behaviors of the molten steel. Wang et al. have
55 conducted the detailed study on the complex interrelationship between the solidified shell
56 surface profile, heat flux, shell thickness, mold level fluctuation, and the infiltrated slag

57 film by using the mold simulator system.^[21] The works regarding the effect of the mold
58 oscillation and mold level fluctuation on the initial solidification behaviors have also
59 been investigated by Wang et al.^[22]

60 Many industrial practices to minimize strand surface defects have been developed,
61 including the non-sinusoidal oscillation,^[23-25] low density and exothermic mold slag,^[26]
62 hot top mold,^[27] and the adjustment of the composition of liquid steel, etc. In addition, the
63 methods to optimize the copper mold structure, such as mold coating, mold taper, inner
64 cavity shape and configuration of cooling channels, have been proposed. Based on the
65 results from industrial trials and mathematical models, Brimacombe et al.^[14] suggested a
66 good slab quality would be expected, through achieving the objectives of having a similar
67 two-broad faces behavior, in which the mold hot-face temperature at the meniscus could
68 be controlled by changing the copper-plate thickness, cooling-channel configuration and
69 mold coatings. Park et al.^[28] built a thermal-elastic-plastic-creep finite element model to
70 investigate the influence of the mold corner radius on the thermo-mechanical behavior
71 and longitudinal crack formation in billet casting. Besides, Samarasekera et al.^[29]
72 designed a new mold taper with the aim to minimize the shell-mold interaction or binding
73 to improve the quality of cast product. Shen et al.^[30] and Hu et al.^[31] studied the effect of
74 the mold corner shape and taper on the temperature and stress distribution in the
75 solidified slab through mathematical simulations, and then proposed a suitable mold
76 corner shape and taper for slab casting. According to the results of electrical analogue and
77 mathematical model in conjunction with plant trials, Patrick et al. suggested that the mold
78 copper end plates with a 40 mm chamfer can reduce the transverse corner cracking of
79 slabs^[32]. However, the research regarding the effect of the mold corner shape on the

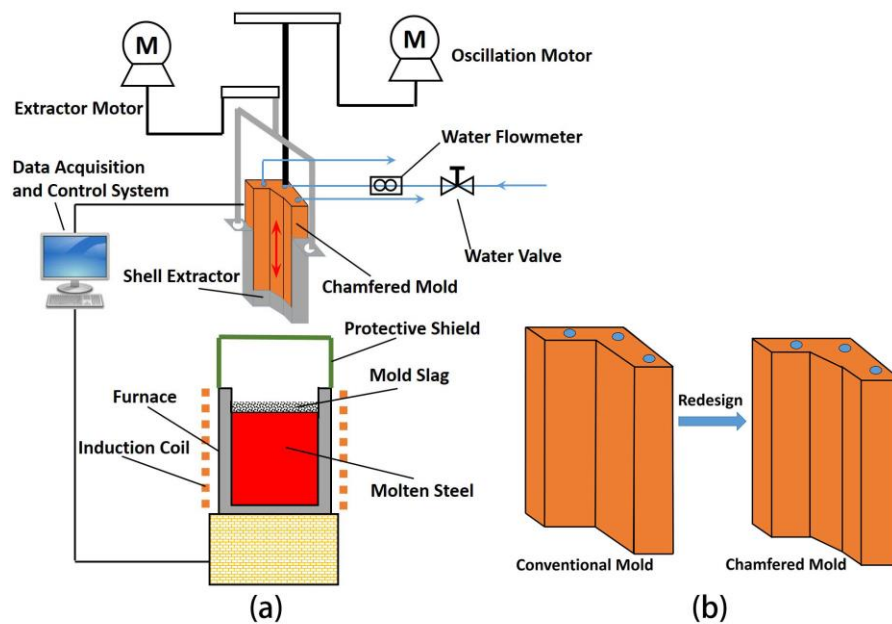
80 initial solidification behaviors around the meniscus region during the continuous casting
81 process, which is of great importance for the optimization of mold corner shape and the
82 control of surface quality, has barely been reported.

83 In this paper, a chamfered mold with a typical corner shape (angle between the
84 chamfered face and hot face is 45 degree) was applied to the mold simulator tests. Then,
85 with the help of the 2D-inverse heat conduction problem (IHCP)^[33], power spectral
86 density (PSD) and fast Fourier transformation (FFT) analysis, the mold surface
87 temperatures and heat fluxes across the mold surface during the casting process were
88 calculated, and their fluctuations at different positions of the mold were also discussed.
89 Next, the solidification factors and surface profiles of the shell were analyzed. Finally, the
90 results in this study were compared with our previous results from a well-developed
91 right-angle mold simulator system,^[34] to understand the effect of the mold corner shape
92 on the initial solidification behaviors of molten steel around the meniscus region.

93 II. EXPERIMENTAL APPARATUS AND PROCESS

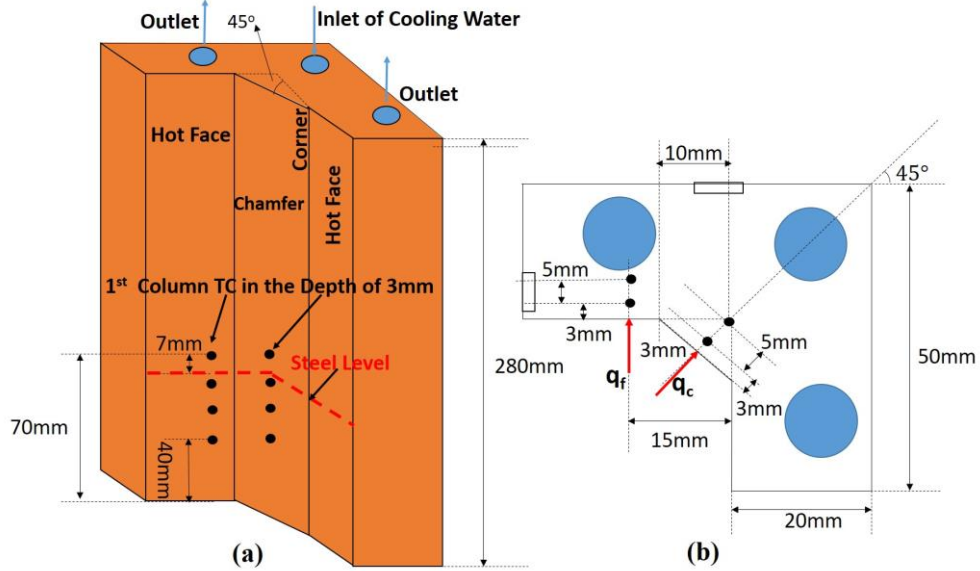
94 As shown in Figure 1, the chamfered mold simulator system applied to this study is
95 constructed based on the previous well-developed right-angle mold simulator system,^[34]
96 and the only difference between above is the corner shape of the mold. The experimental
97 configuration and process in this study are similar to the previous system and have
98 already been described in details^[34]. Except for the corner shape, the size and
99 water-cooling channels for this chamfered one are designed as same as the right-angle
100 mold, which are shown in Figure 2, where q_f and q_c represent the heat fluxes across the
101 mold hot face and chamfer. The in-mold wall temperatures during a mold simulator run
102 are measured by the high-speed data acquisition system (including NI data acquisition

103 card and 16 highly sensitive thermocouples). The acquisition speed is chosen as 60 times
 104 per second based on the Shannon sampling theorem^[35]. As shown in Figure 2 and Figure
 105 3, the distribution principle of thermocouples inside the chamfered mold is as same as the
 106 right-angle mold^[34]. Then the measured in-mold temperatures are delivered to the
 107 **2D-IHCP** mathematical model^[33] to recover the heat fluxes and temperatures on the
 108 mold surface.



109

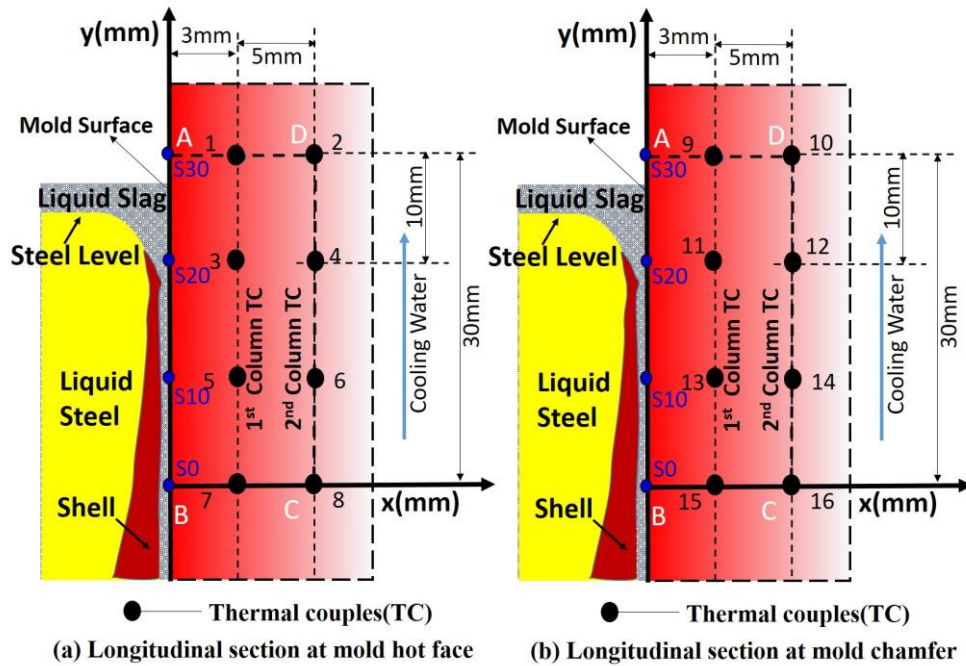
110 Fig. 1—Schematic of the chamfered mold simulator system: (a) chamfered mold
 111 simulator system and (b) redesign of the chamfered copper mold.



112

113 Fig. 2—The size of the chamfered mold: (a) schematic of the chamfered mold and (b)
 114 cross section of the mold.

115



116

117 Fig. 3—Locations of the thermocouples at the mold longitudinal section: (a) longitudinal
 118 section at the mold hot face and (b) longitudinal section at the mold chamfer.

119 The tests have been repeated three times, and the measured in-mold temperatures by

120 the embedded thermocouples are similar to each other. One typical example is shown in

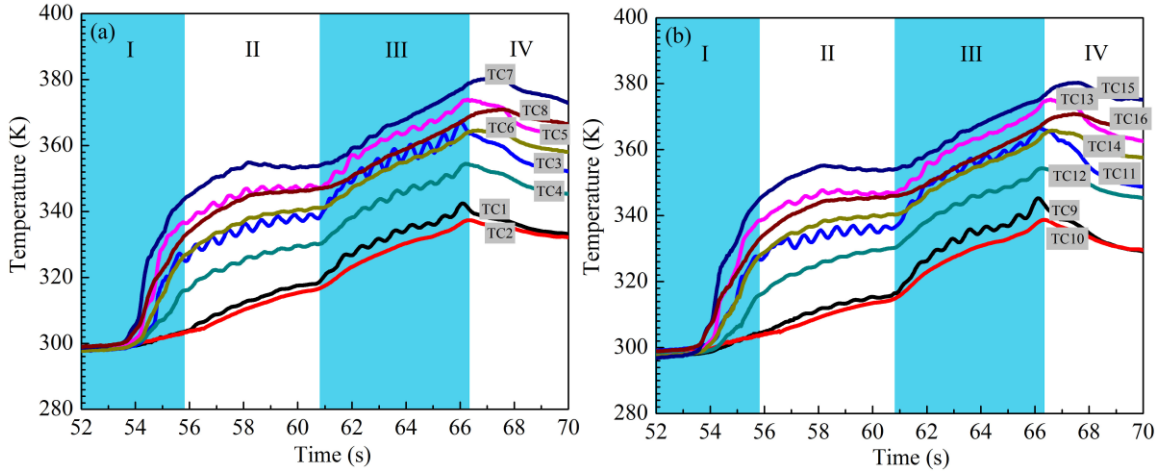
121 **Figure 4.** The steel grade, mold slag **composition and the** casting conditions in the present
122 experiments are as same as the right-angle mold simulator experiments^[34], and shown in
123 **Tables I, II, and III**, respectively. It should be noted that the melt temperature of the
124 liquid steel is measured at first and then the mold simulator system is started, and the
125 measurement error is within ± 2 K (± 2 °C) (by Tungsten-Rhenium thermocouple).
126 Additionally, the duration of the cast (corresponding to the stage **III** in **Figure 4**) is 5.5
127 seconds during a mold simulator run, and the casting length of shell is about 55 mm. In
128 **Figure 3**, rectangle **ABCD** is the computational domain of **2D-IHCP** mathematical
129 model^[33], where **AB** is the mold surface that close to the hot shell and **CD** is another side
130 that close to the cooling channel. **S0~S30** correspond to the locations of points on the
131 mold surface; **S** represents surface and the number represents the value of y-coordinate
132 (mm). As shown in **Figure 3**, the steel level is located at **S23** during the cast period, and
133 the shell tip is located around **S20** when the shell is lifted out of molten steel bath. The
134 thickness of molten slag layer above steel bath during the continuous casting period is
135 about 7 mm. The positions of steel level and shell tip with respect to the mold surface in
136 the present **study are identical** to those in the right-angle mold simulator tests.

137 **III. RESULTS AND DISCUSSION**

138 ***A. Measured Temperatures and Calculated Mold Surface Temperatures***

139 The measured in-mold temperatures by the 16 thermocouples during a mold
140 simulator run are shown in **Figure 4**, where the stage **III** corresponds to the continuous
141 casting process (from 60.8s to 66.3s). **Figure 5** shows the mold surface temperatures at
142 the mold hot face and chamfer, which are calculated by the developed **2D-IHCP**
143 mathematical model^[33]. It can be observed that the mold surface temperatures at the mold

144 chamfer (Figure 5(b)) are very close to those at the mold hot face (Figure 5(a)). For
145 example, the time-average surface temperatures at S20 (around the meniscus) for the
146 mold chamfer and hot face during continuous casting in stage III are 363.1 K (90.1 °C)
147 and 364.1 K (91.1 °C), respectively. For the right-angle mold simulator tests in our
148 previous work^[34], the surface temperatures at the mold corner are lower than those at the
149 mold hot face, due to the two-dimensional heat transfer at horizontal plane around the
150 mold corner, and the time-average surface temperatures at S20 for the mold corner and
151 hot face during continuous casting are 363.6 K (90.6 °C) and 368.2 K (95.2 °C),
152 respectively^[34]. In other words, the homogeneity of temperatures distribution in the
153 chamfered mold is better than that in the right-angle mold. This is because the chamfered
154 structure increases the thermal resistance between the shell and water-cooling channel,
155 and weakens the two-dimensional heat transfer around the mold corner. During the stage
156 III, the fluctuation amplitudes of the mold surface temperatures at S20 for the mold
157 chamfer and hot face are about 2.4 K (2.4 °C) and 3.3K (3.3 °C), respectively. But in the
158 case of right-angle mold simulator, the fluctuation amplitudes at S20 are about 4.5 K (4.5
159 °C) and 2.9 K (2.9 °C) for the mold corner and hot face, respectively. So, it can be found
160 that the chamfered structure does inhibit the fluctuation amplitude of the mold corner
161 surface temperatures, causing the similarity of the surface temperatures between the mold
162 chamfer and hot face.



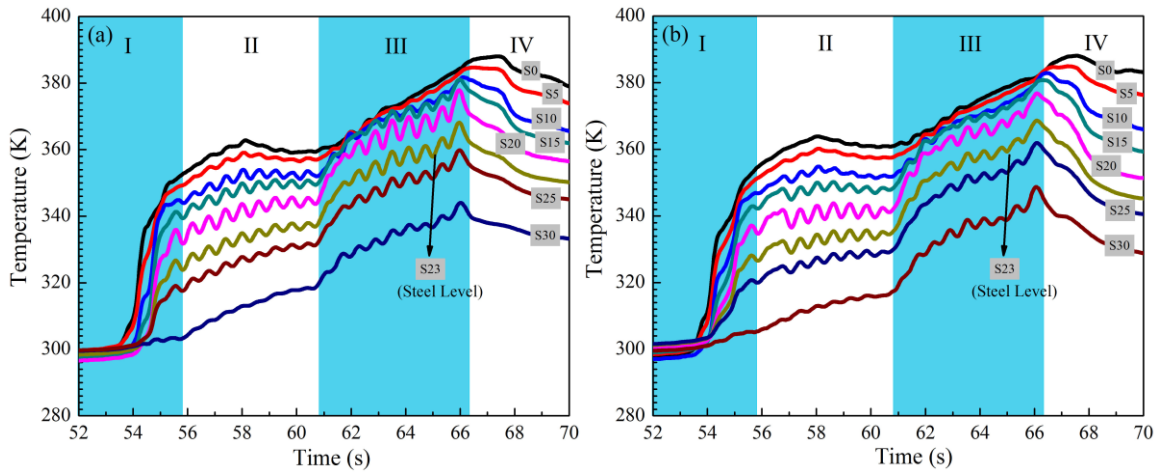
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Fig. 4—The measured in-mold temperatures during a mold simulator run: (a) measured temperatures at the mold hot face and (b) measured temperatures at the mold chamfer.



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Fig. 5—Temperatures at the mold surface calculated by the **2D-IHCP** model: (a) mold surface temperatures at the mold hot face and (b) mold surface temperatures at the mold chamfer.

B. Variation of the Heat Fluxes across Mold Surface, PSD Analysis and FFT Analysis

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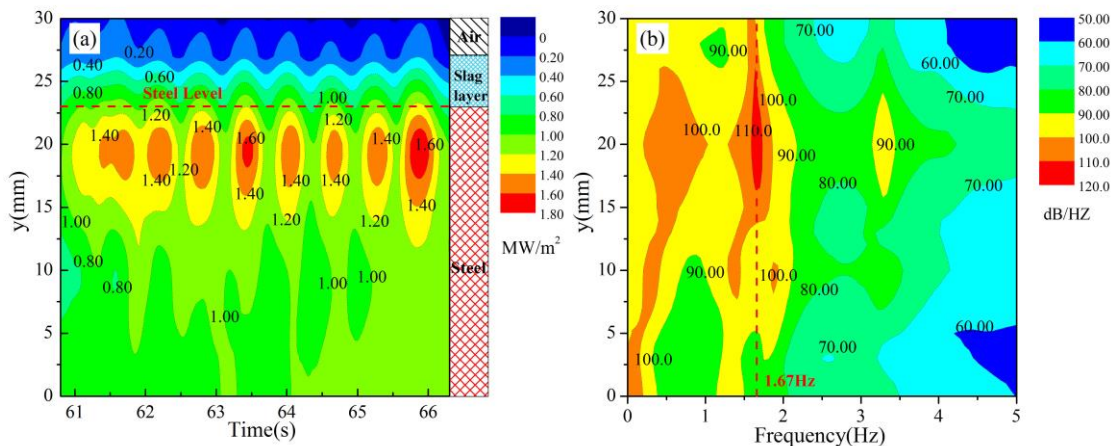
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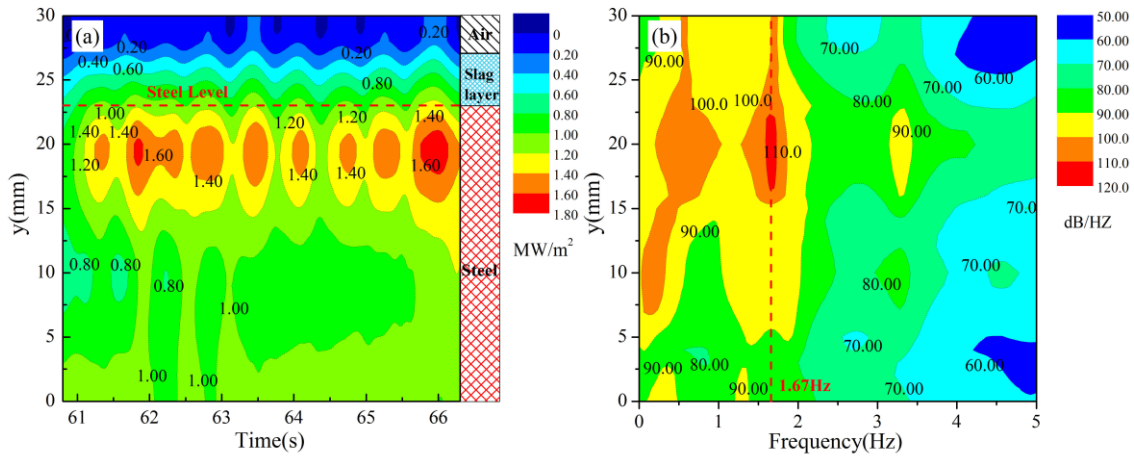
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During the continuous casting process, the heat fluxes across the mold hot face and chamfer are also calculated through the **2D-IHCP** model, and shown in [Figures 6\(a\)](#) and [7\(a\)](#), respectively. It is clear that the general heat fluxes across the mold chamfer are very close to those across the mold hot face. For example, the time-average heat flux at **S20** for the mold chamfer during continuous casting is 1.29 WM/m^2 with the maximum value of 1.81 MW/m^2 , and it is 1.36 WM/m^2 with the maximum value of 1.75 MW/m^2 for the

178 mold hot face. But for the case of right-angle mold simulator ^[34], as the heat dissipation
 179 around the mold corner is two-dimensional, the general heat fluxes at the mold corner are
 180 higher, where the time-average heat flux at S20 is 1.60 WM/m² with the maximum value
 181 of 2.16 MW/m². The existence of the chamfered structure inside the mold increases the
 182 total thermal resistance around the corner and weakens the two-dimensional heat transfer,
 183 and thus decreases the heat fluxes around the mold chamfer, to achieve the
 184 homogenization of the general heat fluxes between the mold chamfer and hot face, which
 185 is consistent with the results reported by Patrick that the heat fluxes are appropriately
 186 uniform around the corner region in the case of larger chamfered mold during the plant
 187 trials ^[32]. Then the PSD analysis ^{[36][37]} is applied to the heat fluxes across both the mold
 188 hot face and chamfer, and the results are shown in Figures 6(b) and 7(b). It can be
 189 observed that the signals of 1.67 Hz in both cases are much stronger than other signals,
 190 and they are identical to the mold oscillation frequency. In addition, the low-frequency
 191 heat flux signals (< 0.8 Hz) can also be observed in Figures 6(b) and 7(b), which are
 192 related to the low-frequency phenomena around the meniscus region, such as air gap
 193 formation, unevenness solidification, and fluctuation of steel level.



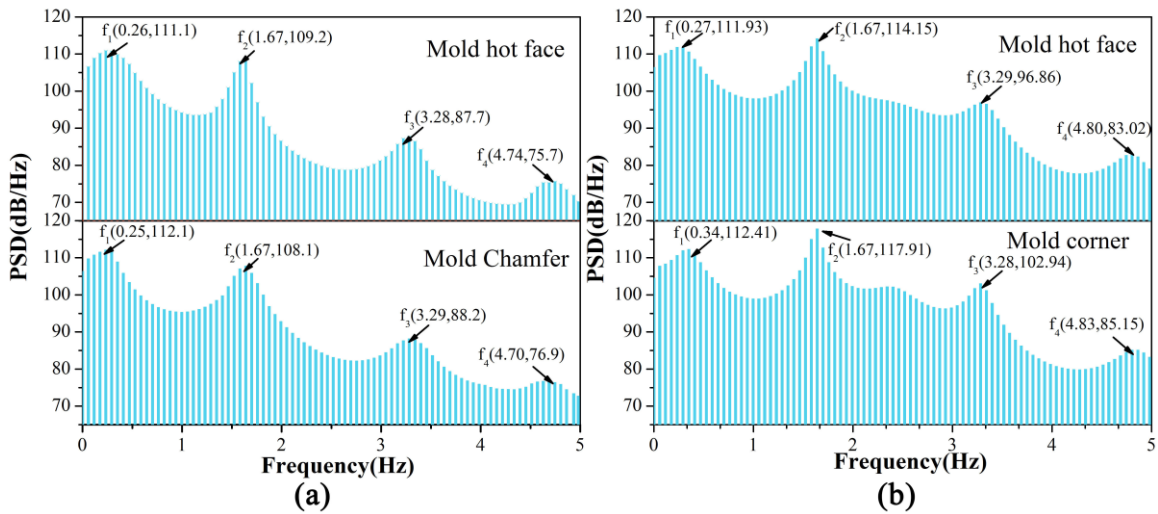
195 Fig. 6—The heat fluxes across mold surface at the mold hot face and their **PSD** analysis
 196 during the continuous casting period: (a) the heat fluxes contour map and (b) the
 197 **PSD** contour map.



198 Fig.7—The heat fluxes across mold surface at the mold chamfer and their **PSD** analysis
 199 during the continuous casting period: (a) the heat fluxes contour map and (b) the
 200 **PSD** contour map.
 201

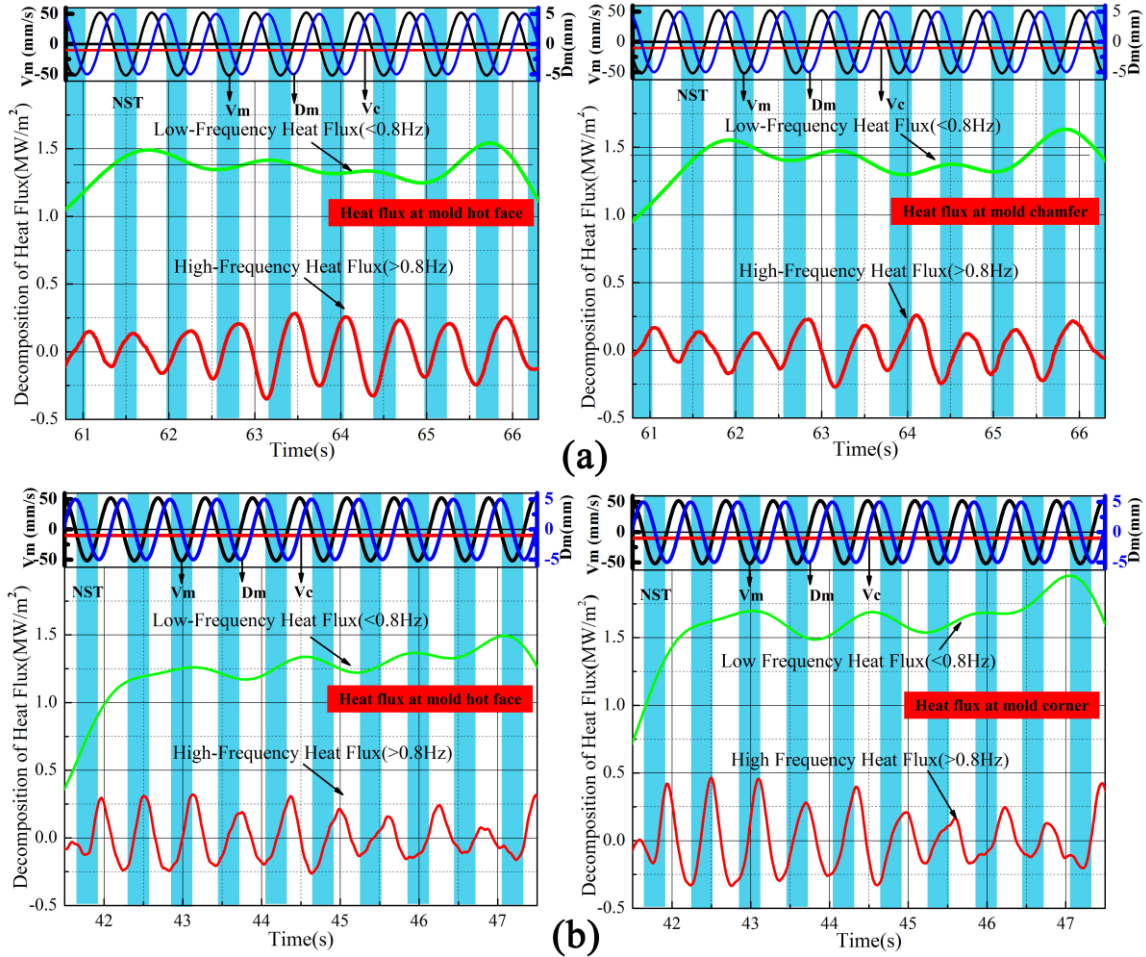
202 The **PSD** analysis results of the heat fluxes at S20 for both cases are shown in
 203 Figures 8. Apparently, there are four characteristic signals with the frequency of $f_1, f_2, f_3,$
 204 and f_4 , respectively, appearing in the figure. Signal f_1 is related to the low-frequency
 205 phenomena, and signals $f_2, f_3,$ and f_4 are related to the high-frequency phenomena. For
 206 all characteristic heat flux signals, the intensity of signals for the mold chamfer is close to
 207 the mold hot face. However, for the case of right-angle mold simulator tests, the intensity
 208 of signals for the mold corner is higher than that for the mold hot face, because of the
 209 unsteadiness of the melt flow around the meniscus in mold corner. So, it may be
 210 concluded that the chamfered structure of copper mold decreases the fluctuation of steel
 211 level and liquid slag flow in the meniscus area. The heat fluxes at S20 are spilt into low-
 212 and high-frequency components through the **FFT** filter^[36,37] with the delineation
 213 frequency of 0.8 Hz, and shown in Figure 9 (a). The low-frequency heat fluxes at S20 for
 214 the mold chamfer and hot face reach relatively steady state with the fluctuation around

215 the baselines of 1.44 WM/m² and 1.38 WM/m², respectively, while the largest fluctuation
 216 amplitudes of the high-frequency heat fluxes for the mold chamfer and hot face are 0.26
 217 WM/m² and 0.34 WM/m², respectively. But for the case of right-angle mold simulator
 218 tests [34], the low-frequency heat fluxes at S20 for the mold corner and hot face reach
 219 relatively steady state around the baselines of 1.67 WM/m² and 1.31 WM/m²,
 220 respectively, while the largest fluctuation amplitudes of the high-frequency heat fluxes for
 221 mold corner and hot face are 0.46 WM/m² and 0.31 WM/m², respectively, as shown in
 222 Figure 9 (b). It suggests that the baselines of the low-frequency heat fluxes or the
 223 fluctuation amplitudes of the high-frequency heat fluxes for the mold chamfer and hot
 224 face are closer to each other, which is due to the designed chamfered structure around the
 225 corner that shows the capability to homogenize the fluctuation of steel level and liquid
 226 slag flow around the mold corner.



227

228 Fig.8—The PSD analysis of the heat fluxes at S20 during the continuous casting period:
 229 (a) PSD of the heat fluxes across mold surface for the chamfered mold simulator
 230 tests and (b) PSD of the heat fluxes across mold surface for the right-angle mold
 231 simulator tests [33].
 232

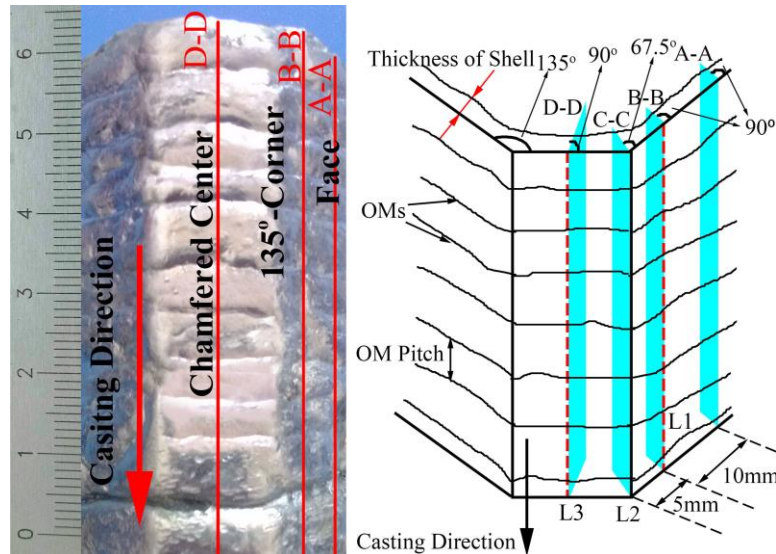


233
 234 Fig. 9—The decomposition of the heat fluxes at S20 during the continuous casting period:
 235 (a) the heat fluxes across mold surface for the chamfered mold simulator tests and
 236 (b) the heat fluxes across mold surface for the right-angle mold simulator tests^[33].
 237

238 C. Thickness of Initial Solidified Shell and Thickness Fitting

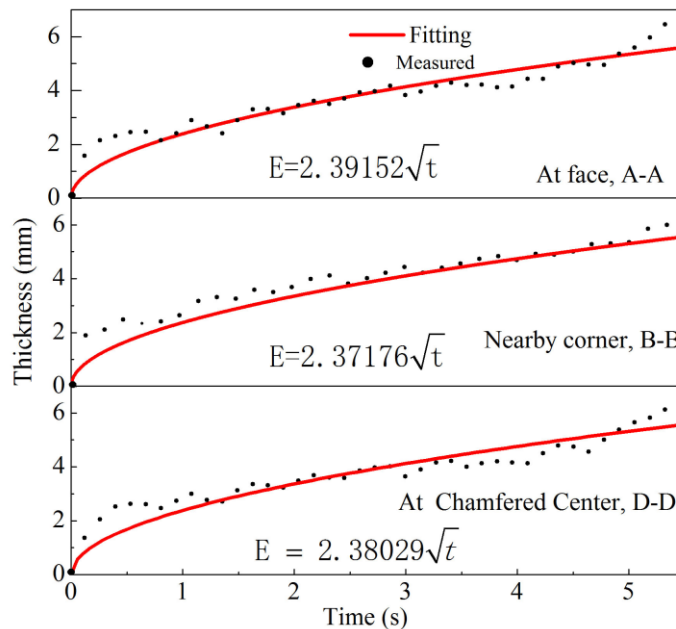
239 Figure 10 shows the initial solidified shell obtained from this study, from which three
 240 longitudinal sections (section **A-A**, section **B-B** and section **D-D**) were cut. Then the
 241 thickness (E , mm) of the shell versus time t ($t = L/Vc$), where L (mm) is the length of
 242 shell and Vc (mm/s) is the casting speed at different sections, is fitted with the
 243 solidification square root law: $E = \bar{K}\sqrt{t}$ (where \bar{K} is the time-average solidification
 244 factor, $\text{mm/s}^{1/2}$), as shown in Figure 11. The time-average solidification factors are 2.392
 245 $\text{mm/s}^{1/2}$ (**A-A**), 2.372 $\text{mm/s}^{1/2}$ (**B-B**) and 2.380 $\text{mm/s}^{1/2}$ (**D-D**), respectively, and it may

246 imply that the cooling intensities at different parts of the shell are close to each other due
 247 to the similar time-average solidification factors. For the right-angle mold simulator tests,
 248 the cooling intensity at the corner is stronger, and the corresponding solidification factor
 249 is $2.766 \text{ mm/s}^{1/2}$ that is higher than others. Therefore, it is confirmed again that the
 250 chamfered structure can improve the heat-transfer uniformity of the copper mold.



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 252
 253

Fig. 10—The initial solidified shell: (a) the shell obtained from this study and (b) the schematic of the shell.



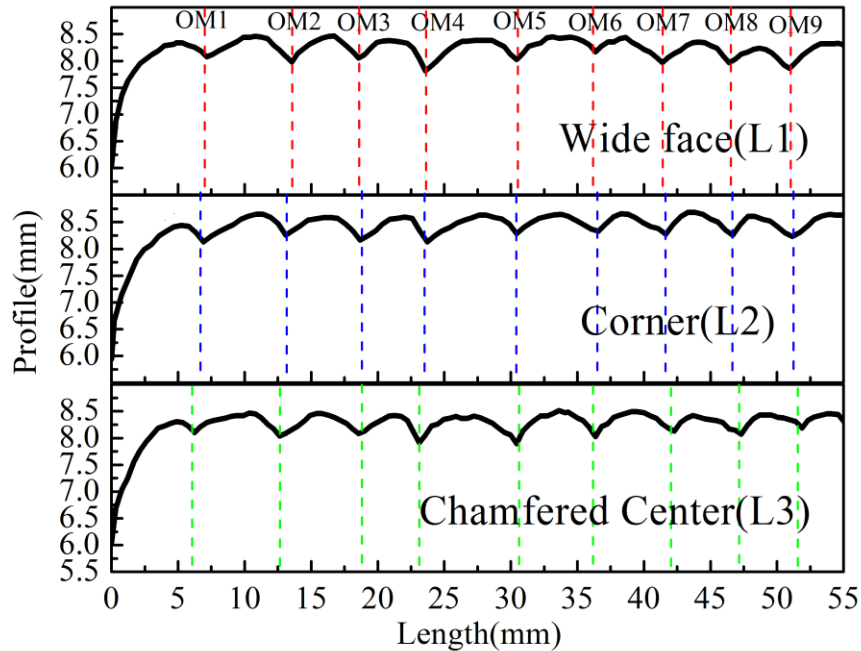
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Fig. 11—Thickness fitting of the shell at different positions.

256 **D. The Surface Profile of the Initial Solidified Shell and Its Metallographic**
257 **Examination**

258 The surface profiles (L1, L2 and L3) for different parts of the shell shown in Figure
259 12 were measured by a contact profilometer, in which OM1~OM9 represent the OMs on
260 the shell surface. It can be found that for the same OM, the heights of OM roots at
261 different positions (L1, L2 and L3) are very close to each other, which differs from the
262 case of right-angle mold simulator tests^[34]. The measured pitch, depth, and height
263 difference (H_D) for each OM are listed in Table IV. The average OM pitches for profile
264 L1, L2 and L3 are 5.52 mm, 5.57 mm and 5.68 mm, respectively, which are slightly
265 lower than the theoretical OM pitch, $T_{pitch} = one\ cycle\ time \times Vc = 0.6\ s \times 10\ mm/s = 6$
266 mm. This difference may be caused by the fluctuation of casting speed or steel level. The
267 average OM depths for profile L1, L2 and L3 are 0.44 mm, 0.45 mm and 0.45 mm,
268 respectively, which are close to that for the case of right-angle mold simulator tests (0.42
269 mm at face and 0.46 mm at corner). Clearly, the most different profile character between
270 the chamfered shell and the right-angle shell is the H_D between two OM roots for the
271 same OMs. The average value of H_D between two OMs roots for L1 and L2 is 0.22 mm,
272 and for L2 and L3 is 0.38 mm. But for the case of right-angle shell, the maximum value
273 of H_D between two roots (at corner and face) for the same OMs is 2.88 mm, the
274 minimum value is 0.49 mm and the average value is 1.65 mm. The reason could be
275 explained as the deeper penetration of the overflowing molten steel occurred around the
276 shell corner due to the formed larger corner gap^[34]. As discussed above, the cooling
277 intensities of the chamfered mold at different positions are close to each other, which
278 causes the similar solidification shrinkage. Therefore, the gap sizes between the shell and

279 mold wall at different positions (such as the chamfered center, 135° corner and hot face)
 280 are expected to be similar. Consequently, the penetration of the overflowing molten steel
 281 between the shell and mold wall is similar; thus the value of H_D is very small.

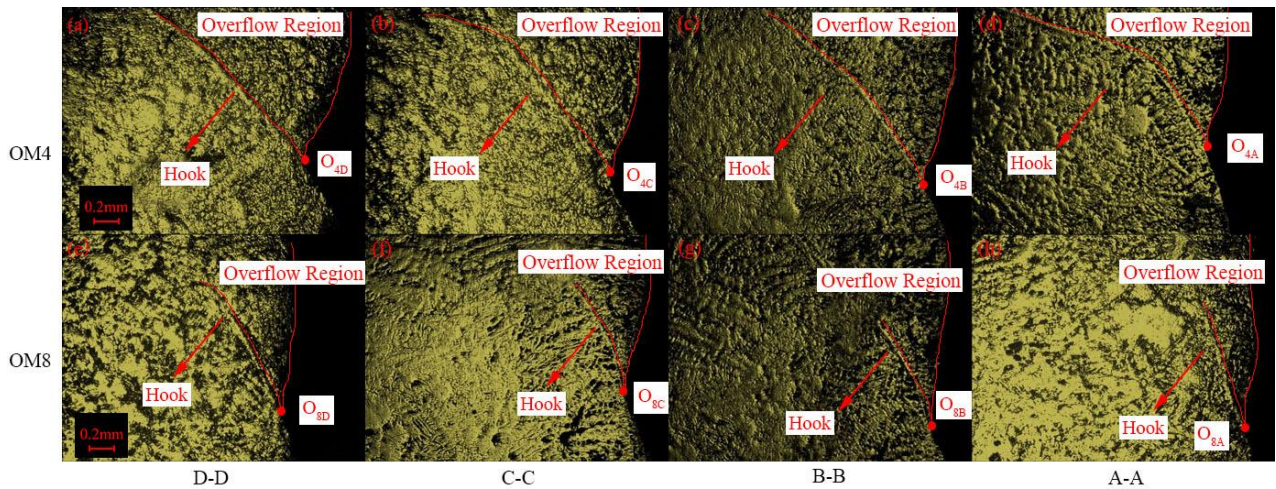


282

283 Fig.12—The measured profile of shell surface at different positions
 284 Metallographic examinations of the shells have been conducted for the observations

285 of the sub-surface microstructure in the vicinity of **OMs**. In the present study, **OM4** and
 286 **OM8** are chosen as the representatives for the metallographic examinations, where the
 287 formation of **OM8** is prior to **OM4**. Figure 13 shows the metallographs of different
 288 sections (**A-A**, **B-B**, **C-C** and **D-D**) for **OM4** and **OM8**, where the hook shape and
 289 overflow region can be observed. For the same **OM**, the hook shapes are similar to each
 290 other at different positions of the shell. This may be attributed to the similar phenomena
 291 occurred at different positions (**A-A**, **B-B**, **C-C** and **D-D**) around the meniscus, i.e. (i)
 292 cooling ability (ii) steel level fluctuation and (iii) pressure from liquid slag channel^[38] or
 293 pressure from slag rim^[39]. As shown in Figure 13, it is found that the hook length and

294 hook-bending angle of **OM4** is larger than those of **OM8**. As suggested by Thomas et
 295 al.^[40] that hooks are initiated by the meniscus solidification; hence, during the formation
 296 of **OM4**, the longer hook length for **OM4** may be due to the lower superheat around the
 297 meniscus region, and correspondingly more meniscus solidification. Besides, in a mold
 298 simulator run, the thickness of slag rim attached to the mold surface increases gradually
 299 because of the consecutive cooling by the water-cooling mold. According to the report
 300 that the **OMs** are produced by the interaction between the slag rim and the solidified
 301 meniscus,^[14,41] a thicker slag rim during the negative strip time of the formation of **OM4**
 302 would result in a more intensive interaction between the slag rim and the solidified
 303 meniscus. Consequently, the bending angle of the hook for **OM4** is larger than that for
 304 **OM8**.



305
 306 Fig. 13—Metallographs of the shell around the **OMs**: (a) ~ (d) metallographs of shell
 307 around the **OM4** at different longitudinal sections and (e) ~ (h) metallographs
 308 of shell around the **OM8** at different longitudinal sections.
 309

310 IV. CONCLUSIONS

311 The chamfered mold simulator system has been used in this paper to study the initial
 312 solidification behaviors of the molten steel around the meniscus inside the chamfered

313 mold. Also, the study results were compared with our previous results from a
314 well-developed right-angle mold simulator system, to understand the effect of mold
315 corner shape on the initial solidification behaviors of molten steel. The main conclusions
316 are summarized as follows:

317 **1.** For the chamfered mold simulator tests, the mold surface temperatures and general
318 heat fluxes at the mold chamfer are very close to those at the mold hot face. In contrast,
319 for the case of the right-angle mold simulator tests, the mold surface temperatures around
320 the corner are lower than those at the mold hot face, and general heat fluxes at the mold
321 corner are larger than those at the mold hot face. This is because the chamfered structure
322 increases the thermal resistance and weakens the two-dimensional heat transfer around
323 the mold corner.

324 **2.** The four characteristic signals f_1 , f_2 , f_3 , and f_4 can be observed from the **PSD** analysis
325 results of the heat fluxes at S20, where the intensities of these signals are close to each
326 other. The similarity of the fluctuation amplitudes of the surface temperatures and heat
327 fluxes for both mold chamfer and hot face suggests that the chamfered structure can
328 decrease the fluctuation of the steel level and liquid slag flow around the meniscus at
329 mold corner.

330 **3.** The thickness of solidified shell (longitudinal section near the corner, at the mold hot
331 face and at the chamfered center) and solidification time accord with the solidification
332 square root law. The cooling intensities at different parts of the chamfered shell are close
333 to each other due to the similar time-average solidification factors, which are 2.392
334 $\text{mm/s}^{1/2}$ (section **A-A**: chamfered center), 2.372 $\text{mm/s}^{1/2}$ (section **B-B**: 135° corner) and
335 2.380 $\text{mm/s}^{1/2}$ (section **D-D**: face), respectively, indicating that the chamfered structure

336 can improve the heat-transfer uniformity of the copper mold.

337 **4.** The gap size formed between the shell and mold wall is expected to be similar due to
338 the similar cooling intensity of the chamfered mold at different positions, which allows
339 the similar penetration of the overflowing molten steel between the shell and mold wall.
340 So, it can be found, for the same **OM**, the heights of **OM** roots at different positions
341 (profile **L1**(face), profile **L2**(135° corner) and profile **L3**(chamfered center)) are very
342 close to each other. The average value of **H_D** between two **OMs** roots for **L1** and **L2** is
343 0.22 mm, and for **L2** and **L3** is 0.38 mm.

344 **5.** The similar hook shape is caused by the similar phenomena occurred around the
345 meniscus, such as cooling ability of chamfered mold, steel level fluctuation, pressure
346 from liquid slag channel and slag rim. A longer hook length may be due to the larger
347 volume meniscus solidification, and a thicker slag rim during the negative strip time
348 would introduce a larger bending angle of the hook.

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352

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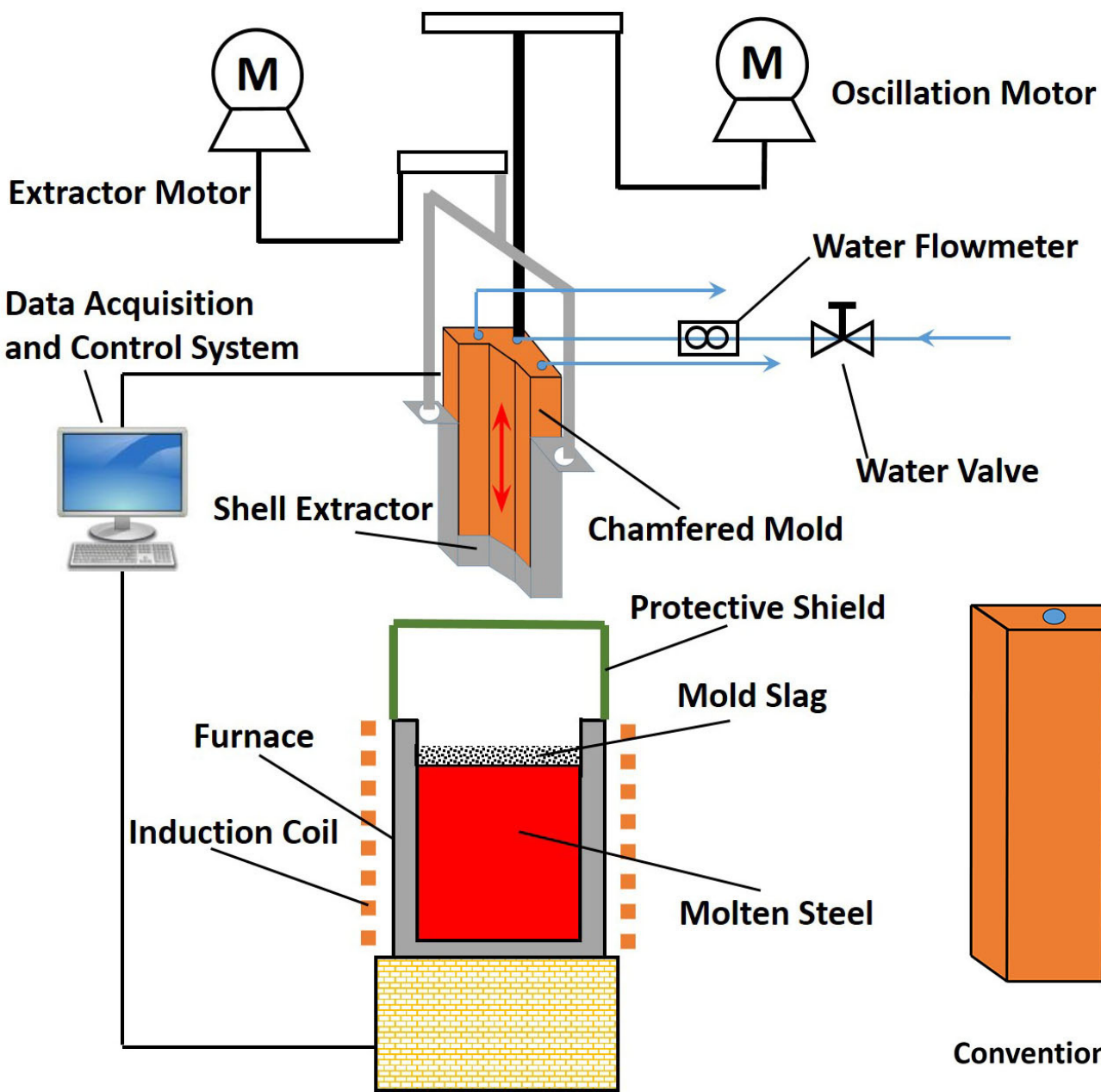
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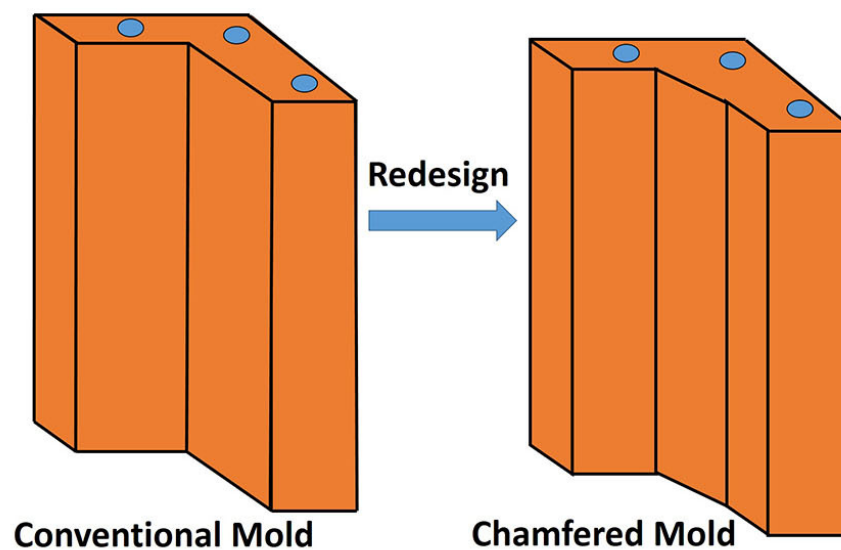
427 **Figure List:**

- 428 Fig. 1—Schematic of **the** chamfered mold simulator system: (a) chamfered mold
- 429 simulator system and (b) redesign of **the chamfered** copper mold.
- 430 Fig. 2—The size of the chamfered mold: (a) schematic of the chamfered mold and (b)
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- 434 Fig. 4—The measured in-mold temperatures during a mold simulator run: (a) measured
- 435 temperatures at the mold hot face and (b) measured temperatures at the mold
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- 437 Fig. 5—Temperatures on the mold surface calculated by **2D-IHCP model**: (a) mold
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- 442 **PSD contour** map.
- 443 Fig. 7—The heat fluxes across mold surface at mold chamfer and their **PSD** analysis
- 444 during the continuous casting period: (a) the heat fluxes contour map and (b) the
- 445 **PSD contour** map.
- 446 Fig. 8—The **PSD** analysis of the heat fluxes at **S20** during the continuous casting period:
- 447 (a) **PSD** of the heat fluxes across mold surface for chamfered mold simulator tests
- 448 and (b) **PSD** of the heat fluxes across mold surface for right-angle mold simulator
- 449 tests^[33].
- 450 Fig. 9—The decomposition of the heat fluxes at **S20** during the continuous casting period:
- 451 (a) the heat fluxes across mold surface for the chamfered mold simulator tests and
- 452 (b) the heat fluxes across mold surface for the right-angle mold simulator tests^[33].
- 453 Fig. 10—The initial solidified shell: (a) the shell obtained from this study and (b) the
- 454 **schematic of the shell**.

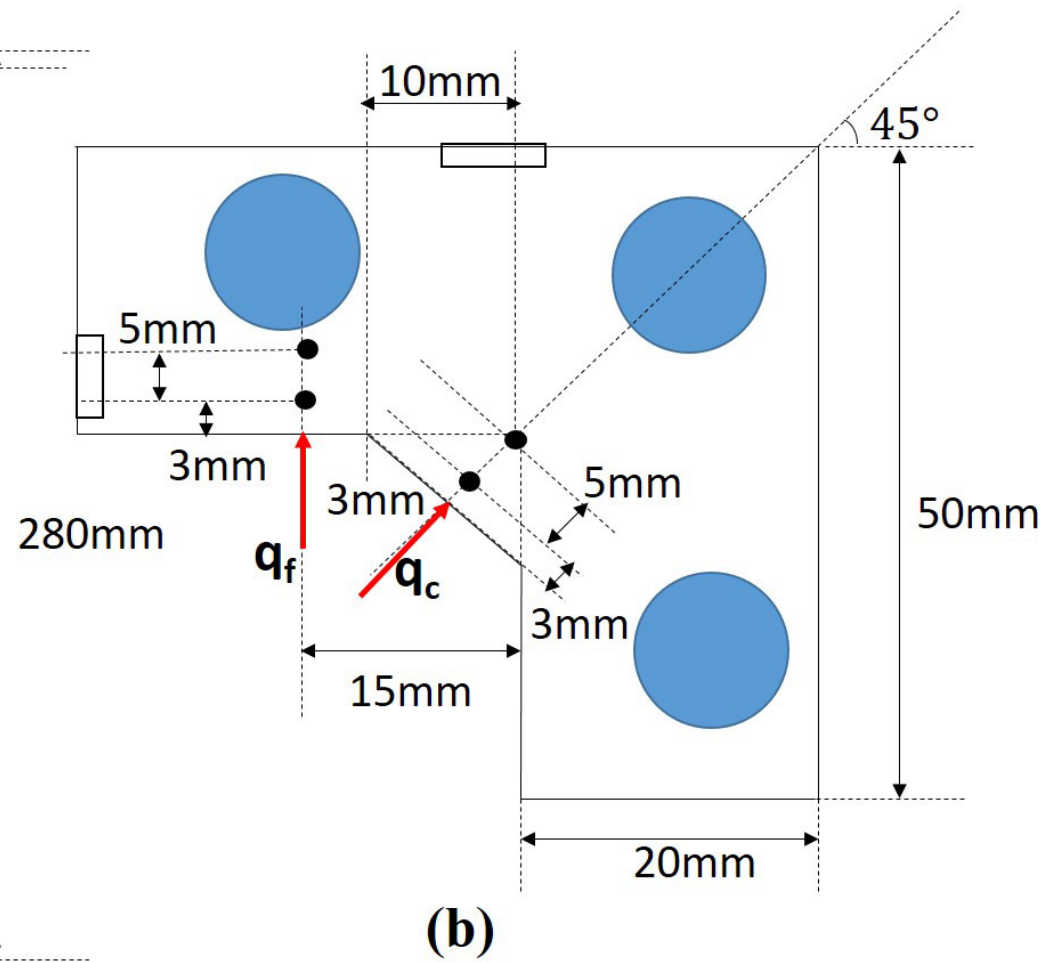
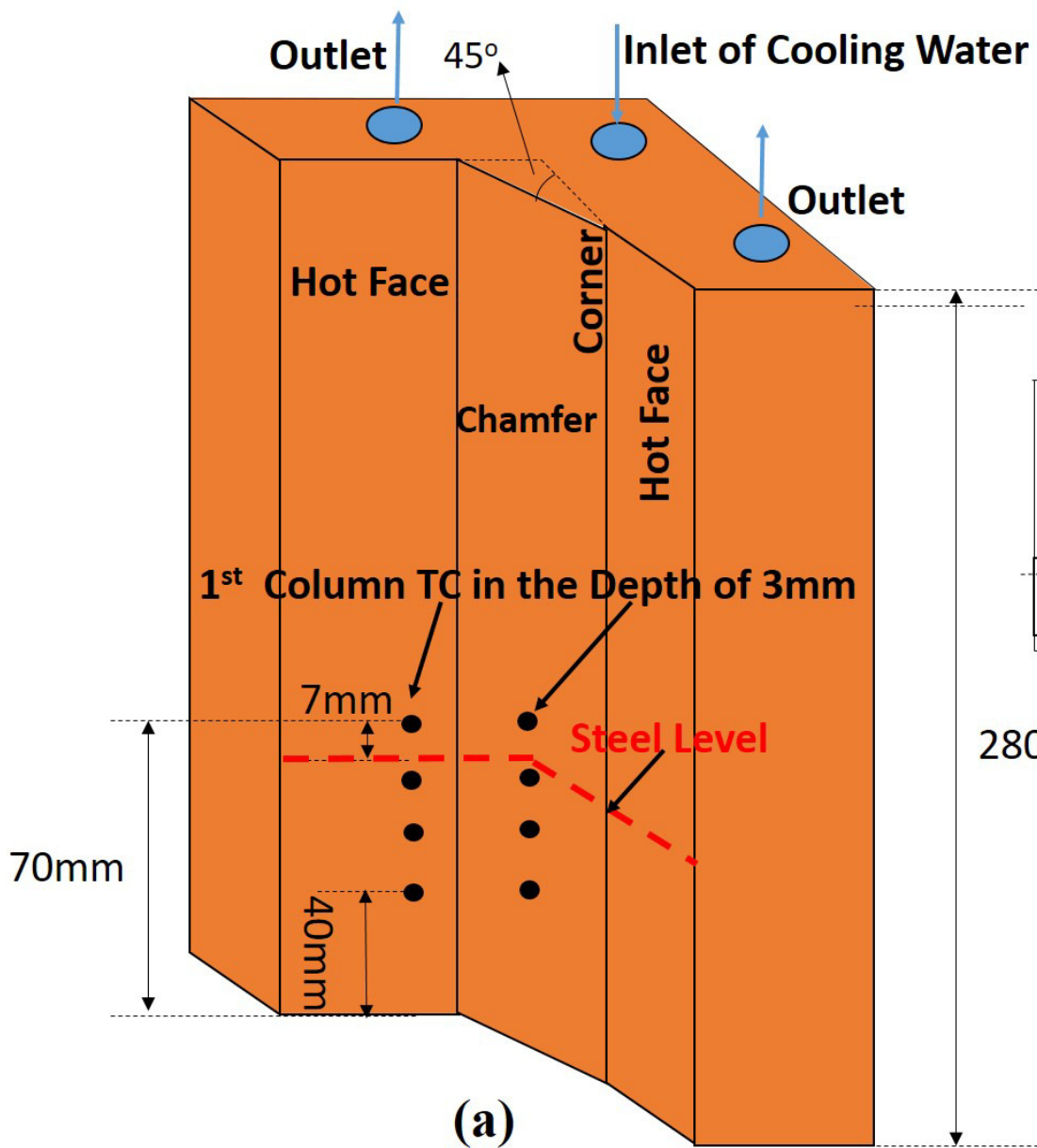
- 455 Fig. 11—Thickness fitting of the shell at different positions.
456 Fig. 12—The measured profile of shell surface at different positions.
457 Fig. 13—Metallographs of the shell around the **OMs**: (a) ~ (d) metallographs of shell
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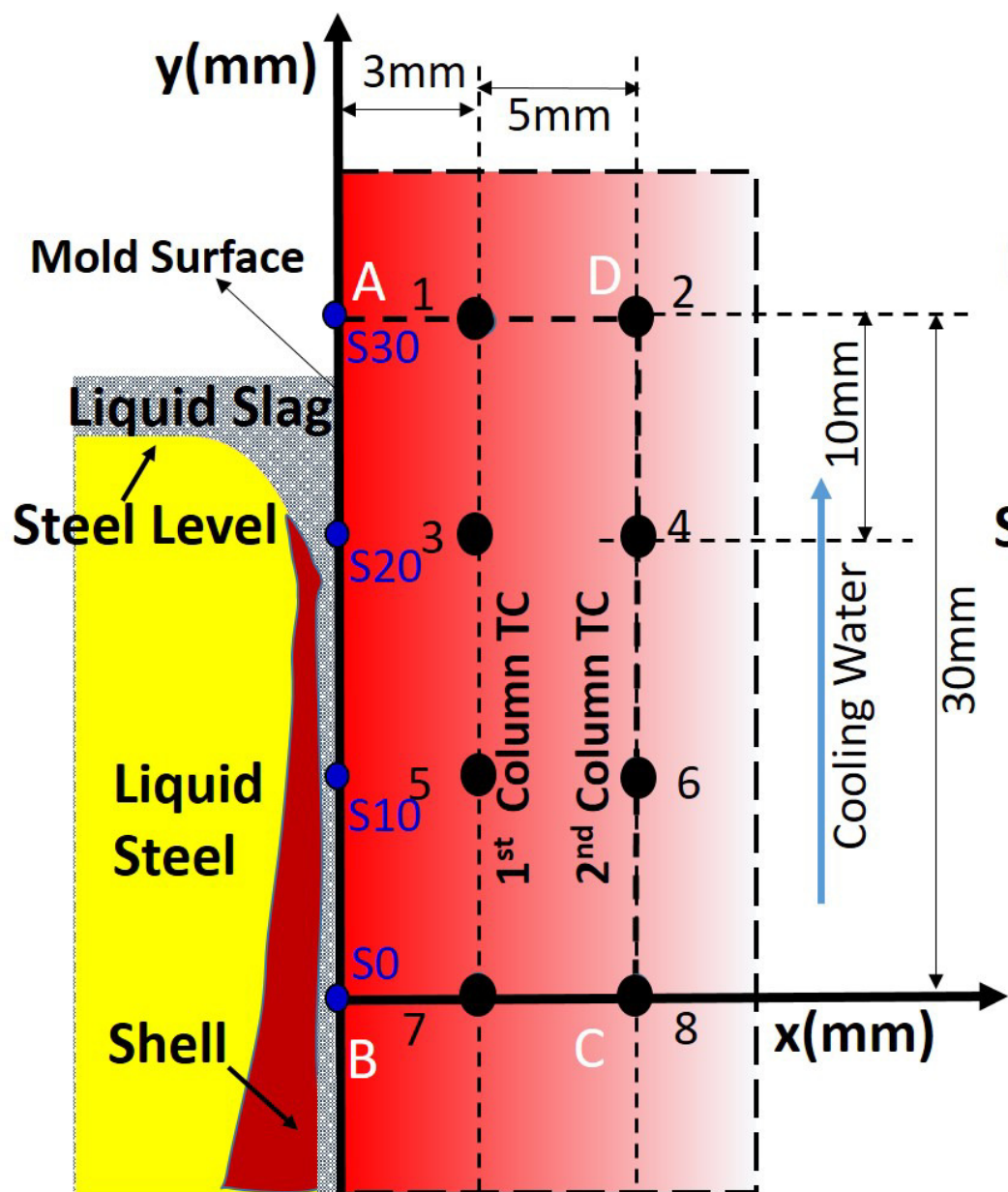


(a)



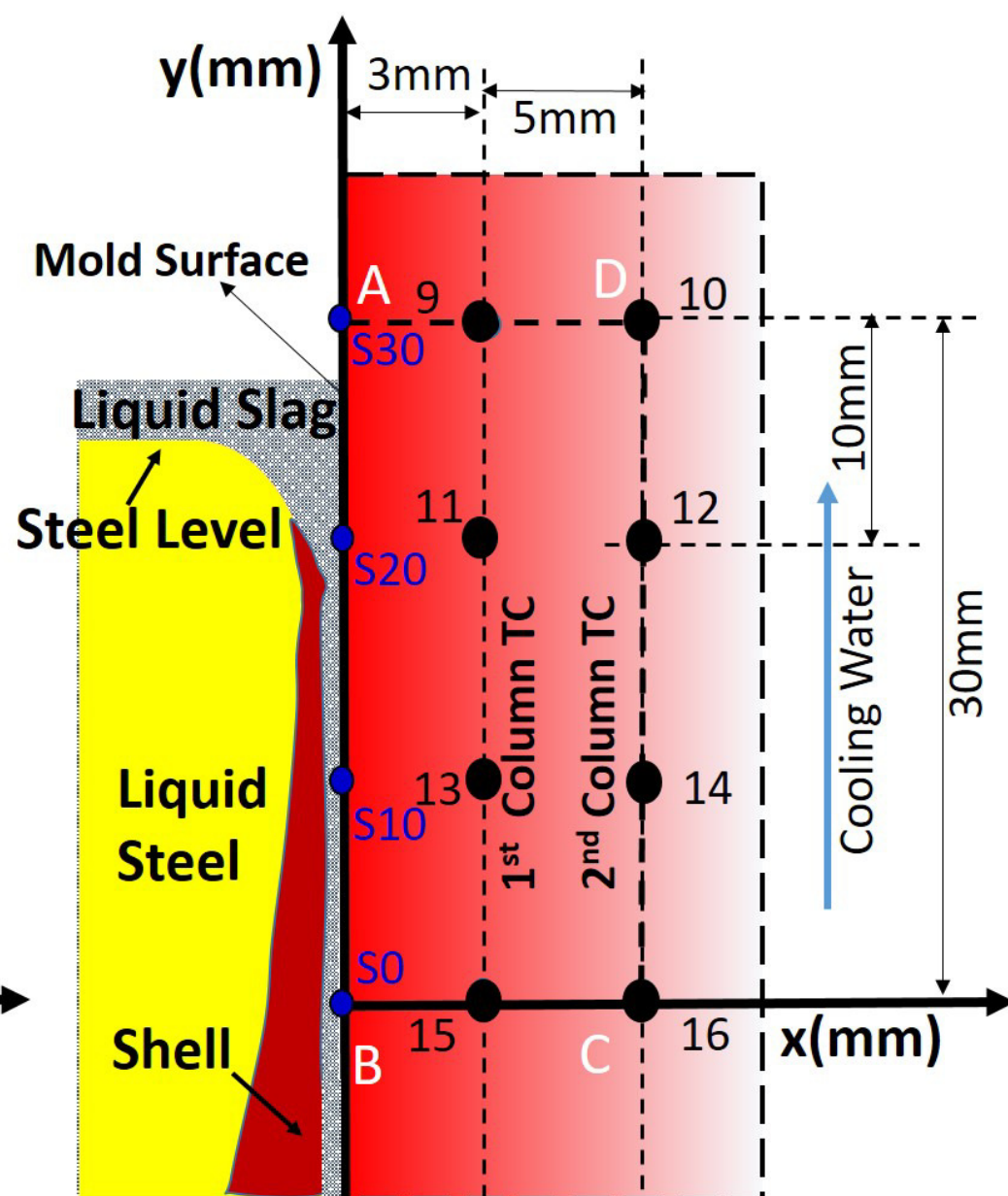
(b)





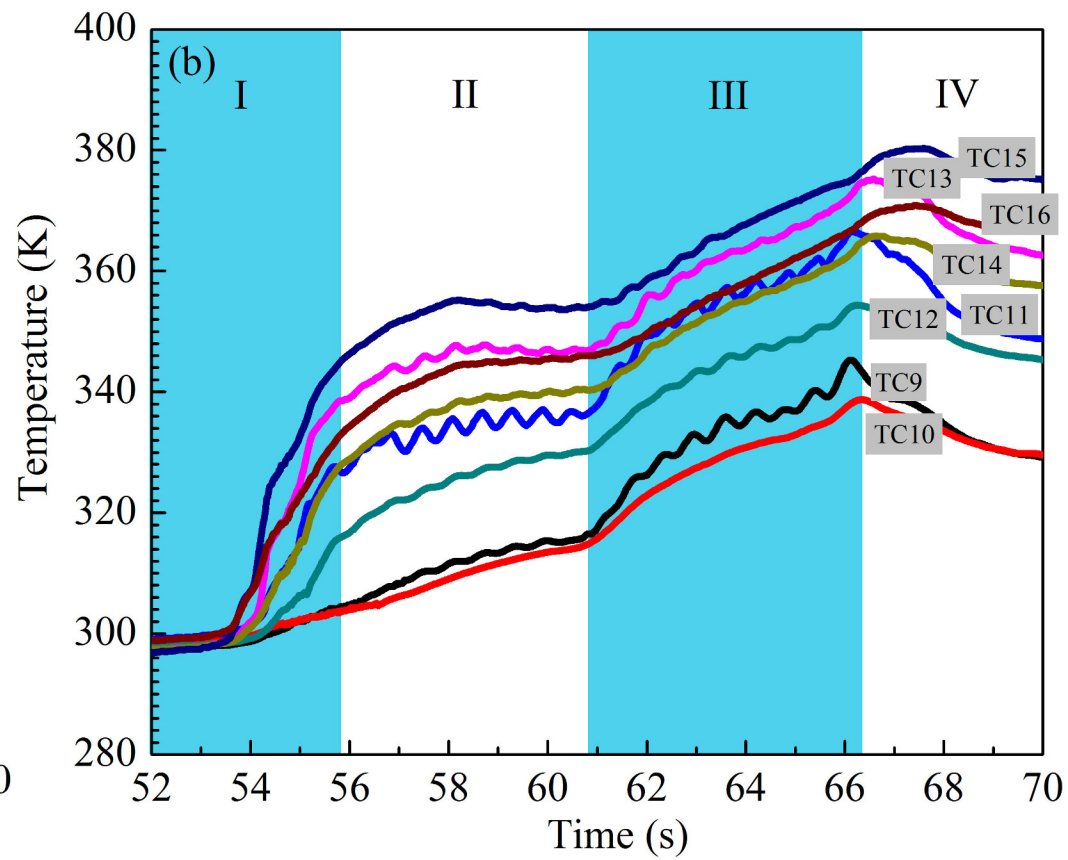
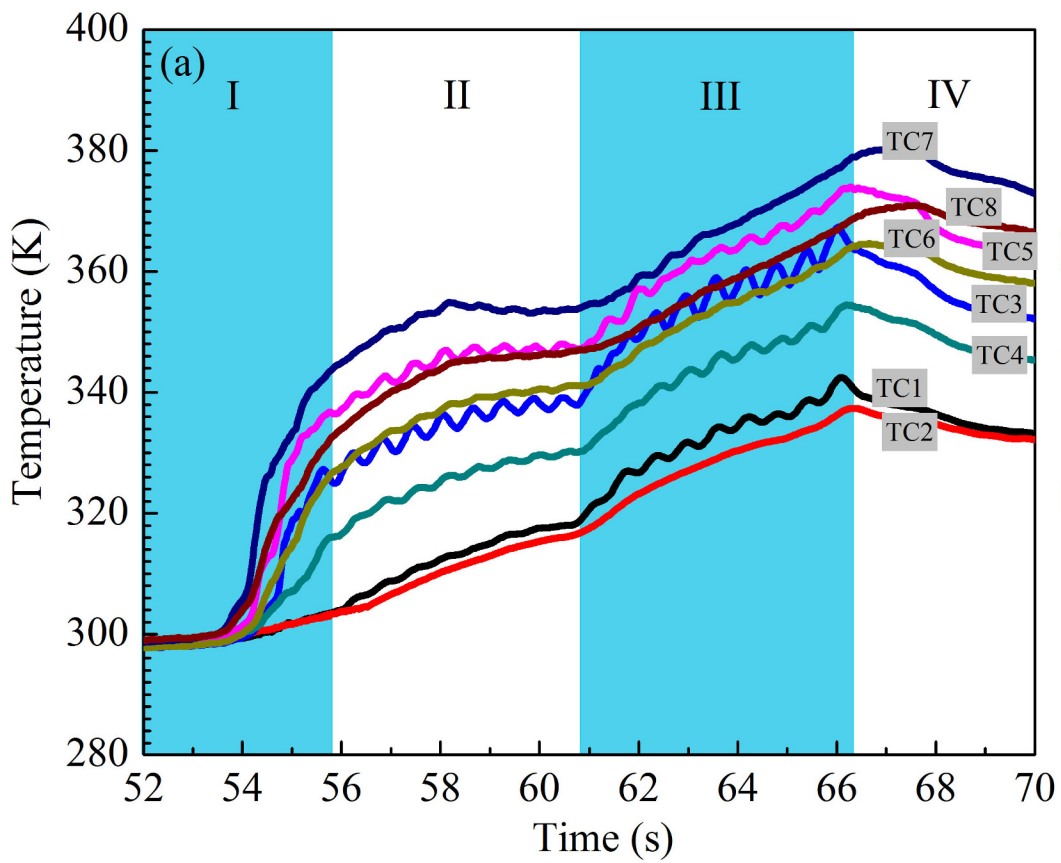
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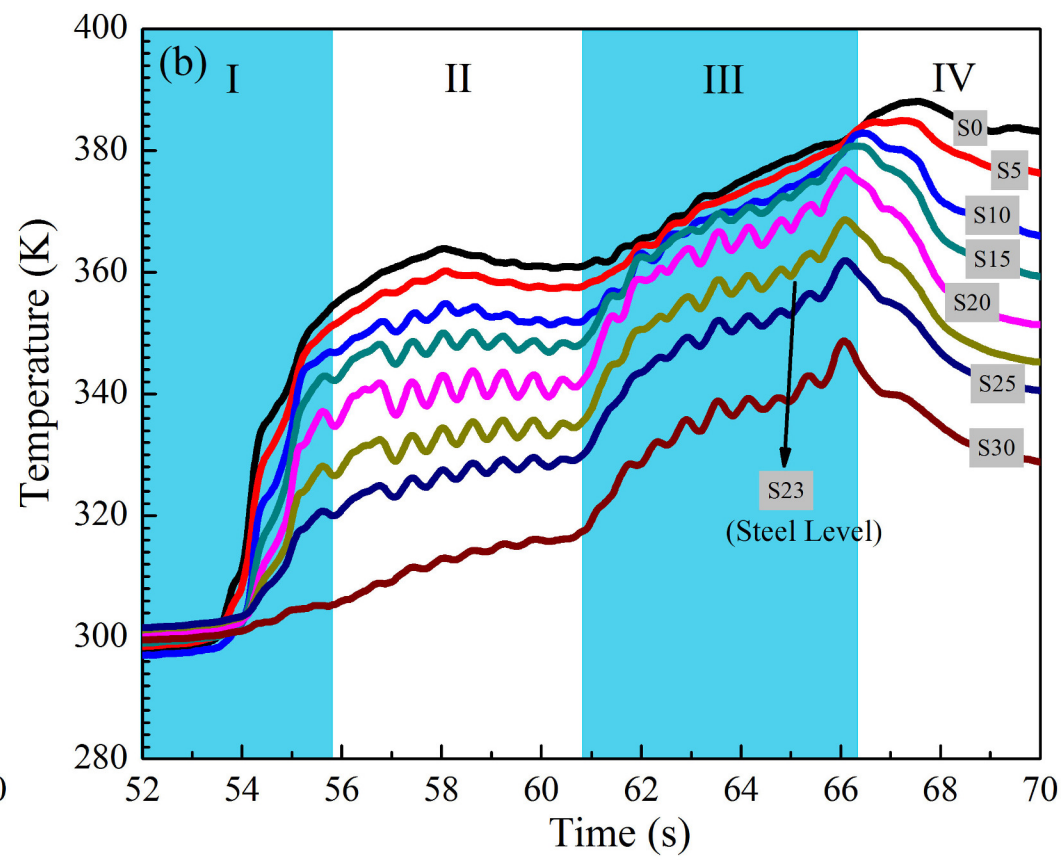
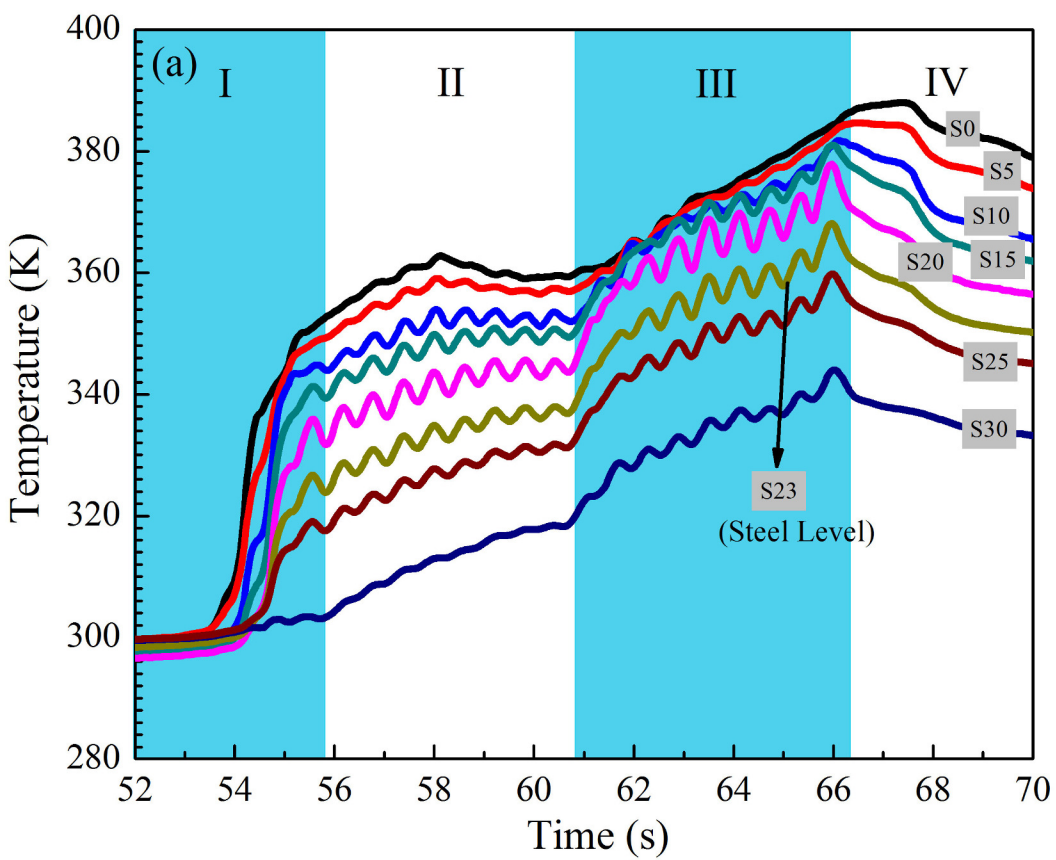
(a) Longitudinal section at mold hot face

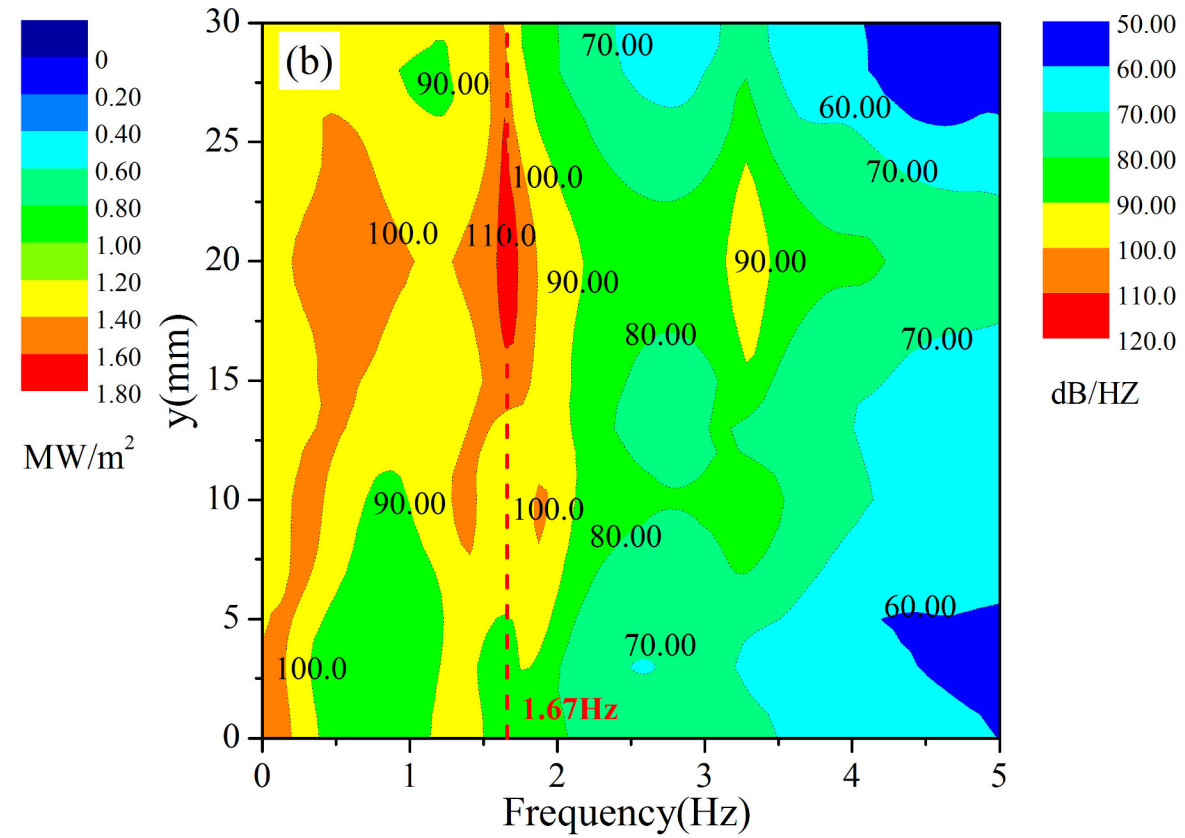
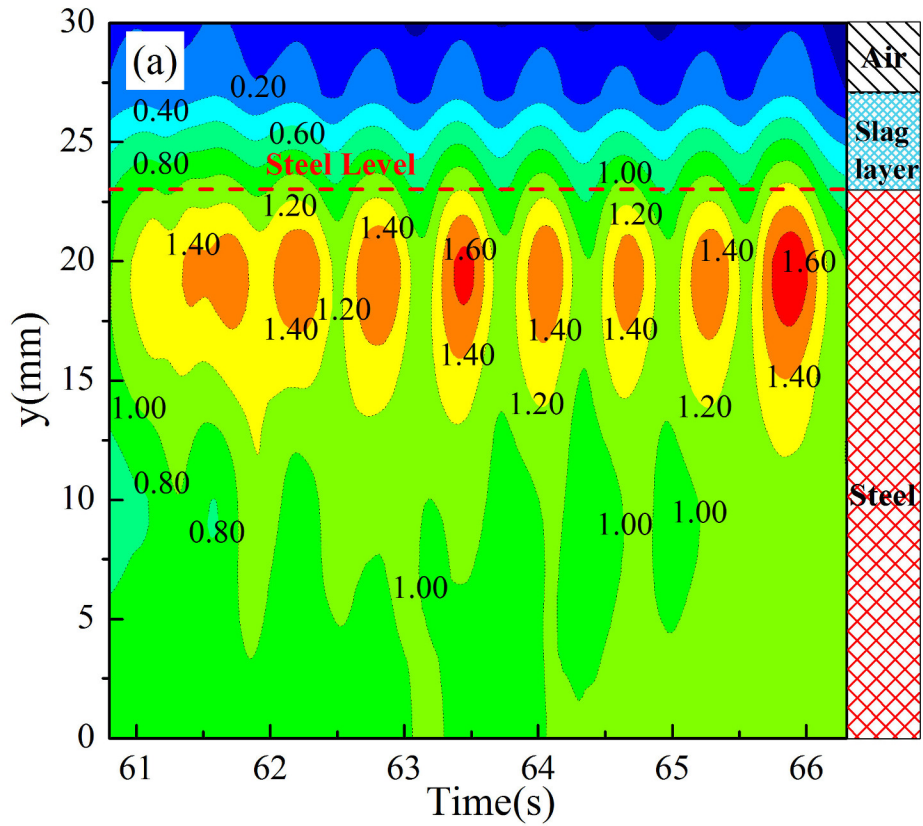


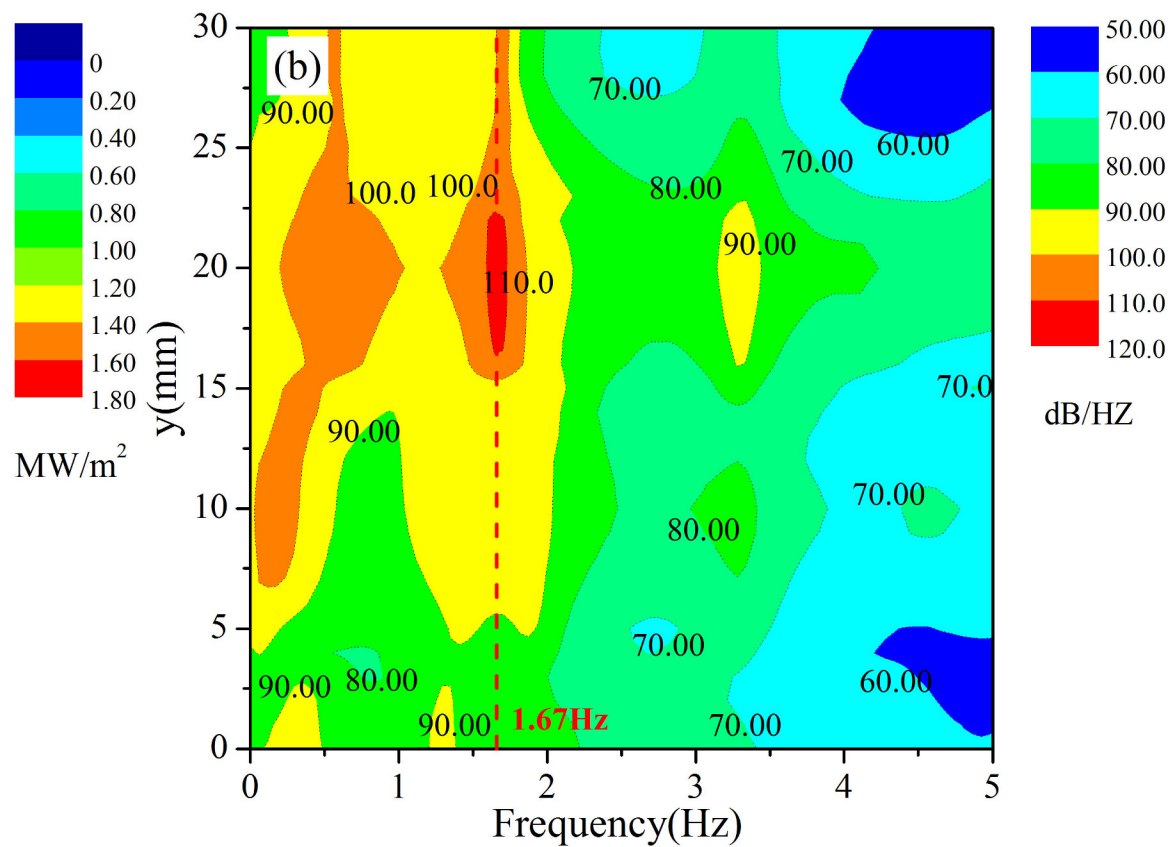
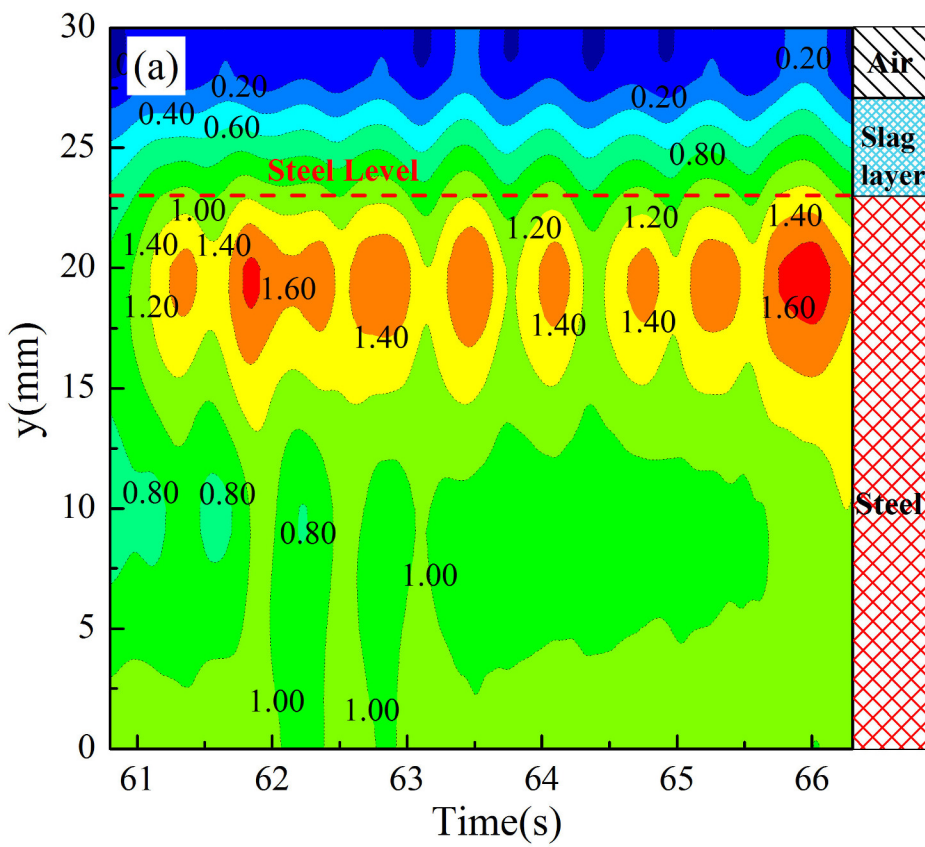
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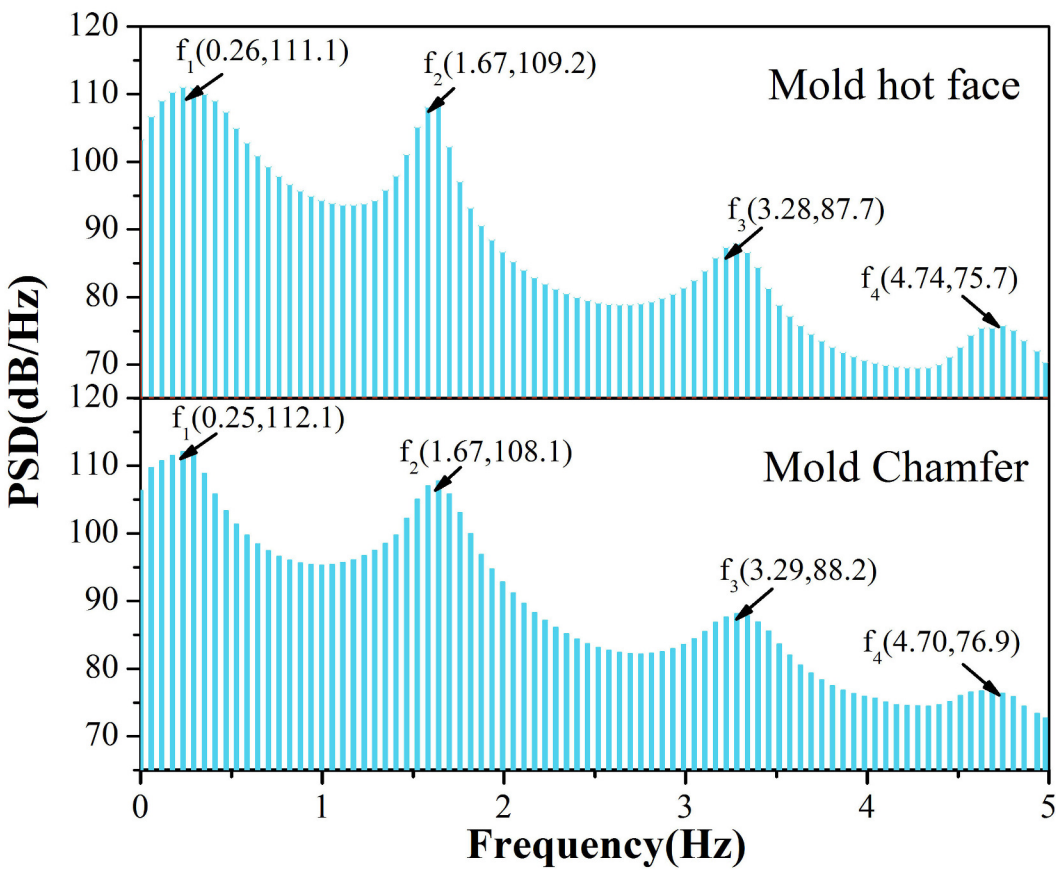
(b) Longitudinal section at mold chamfer



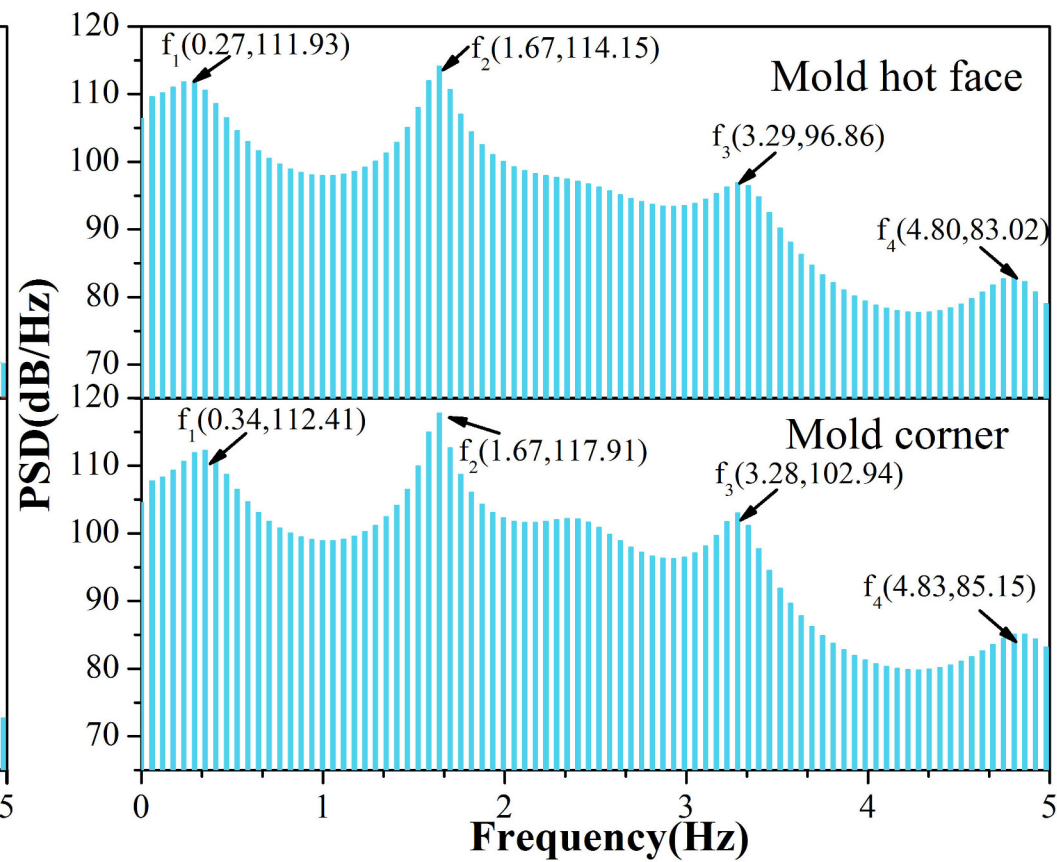




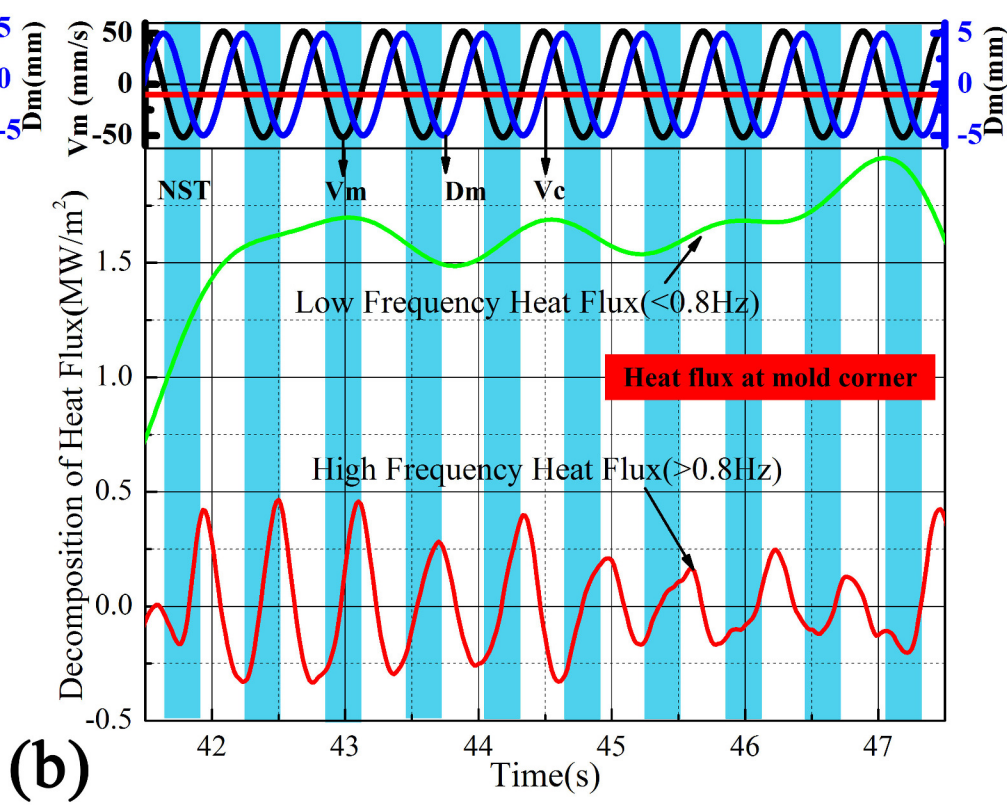
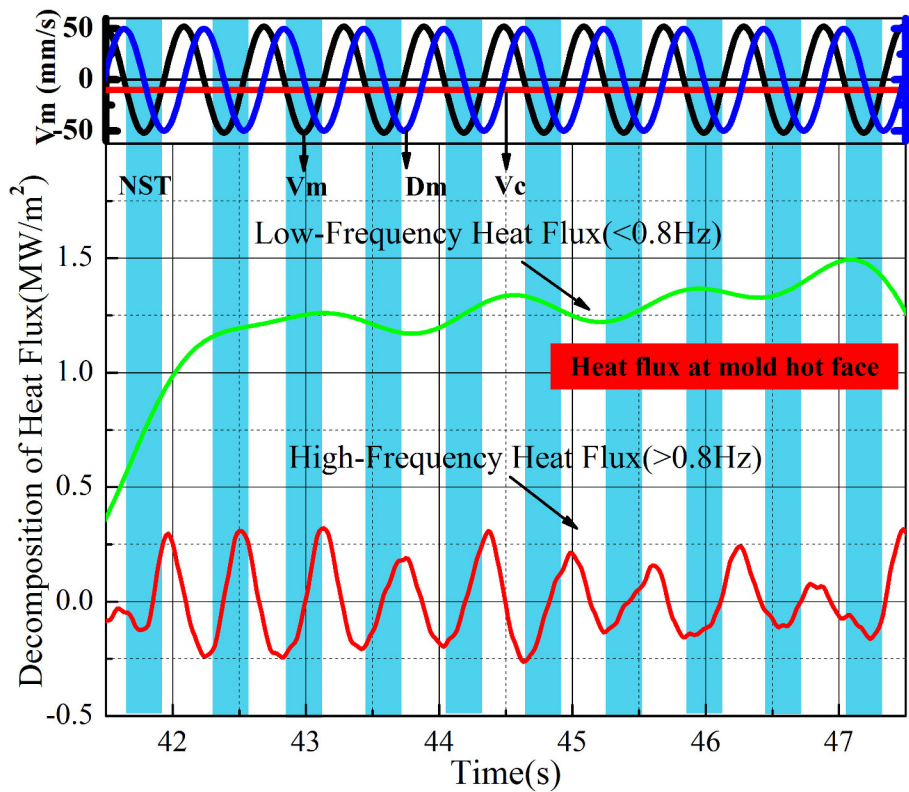
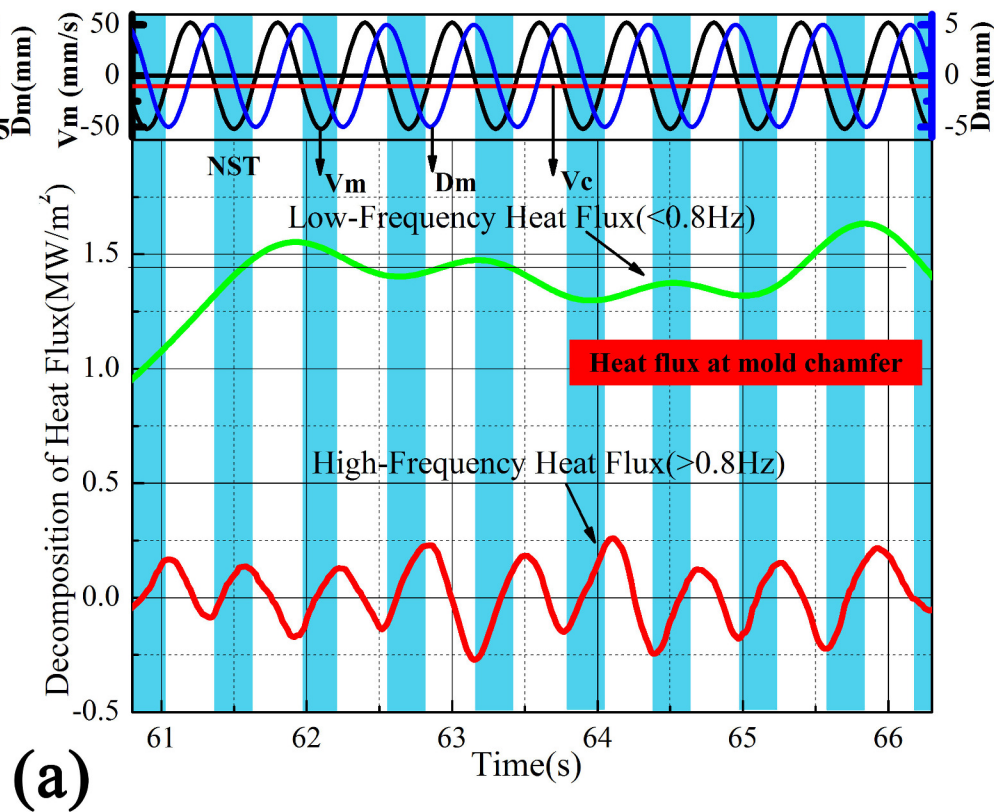
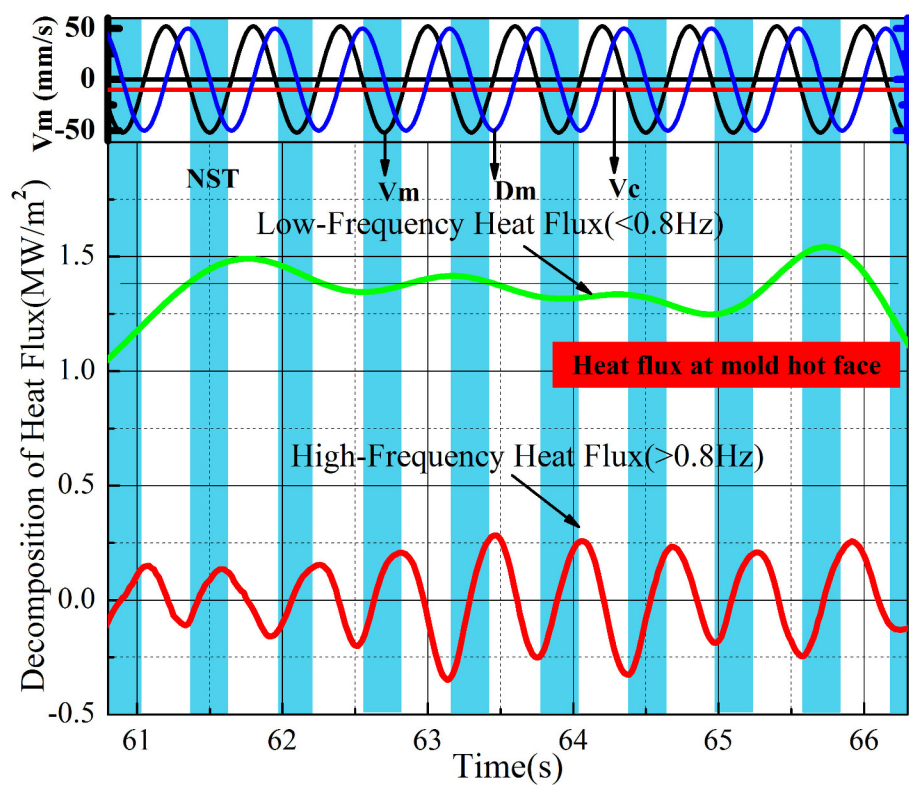


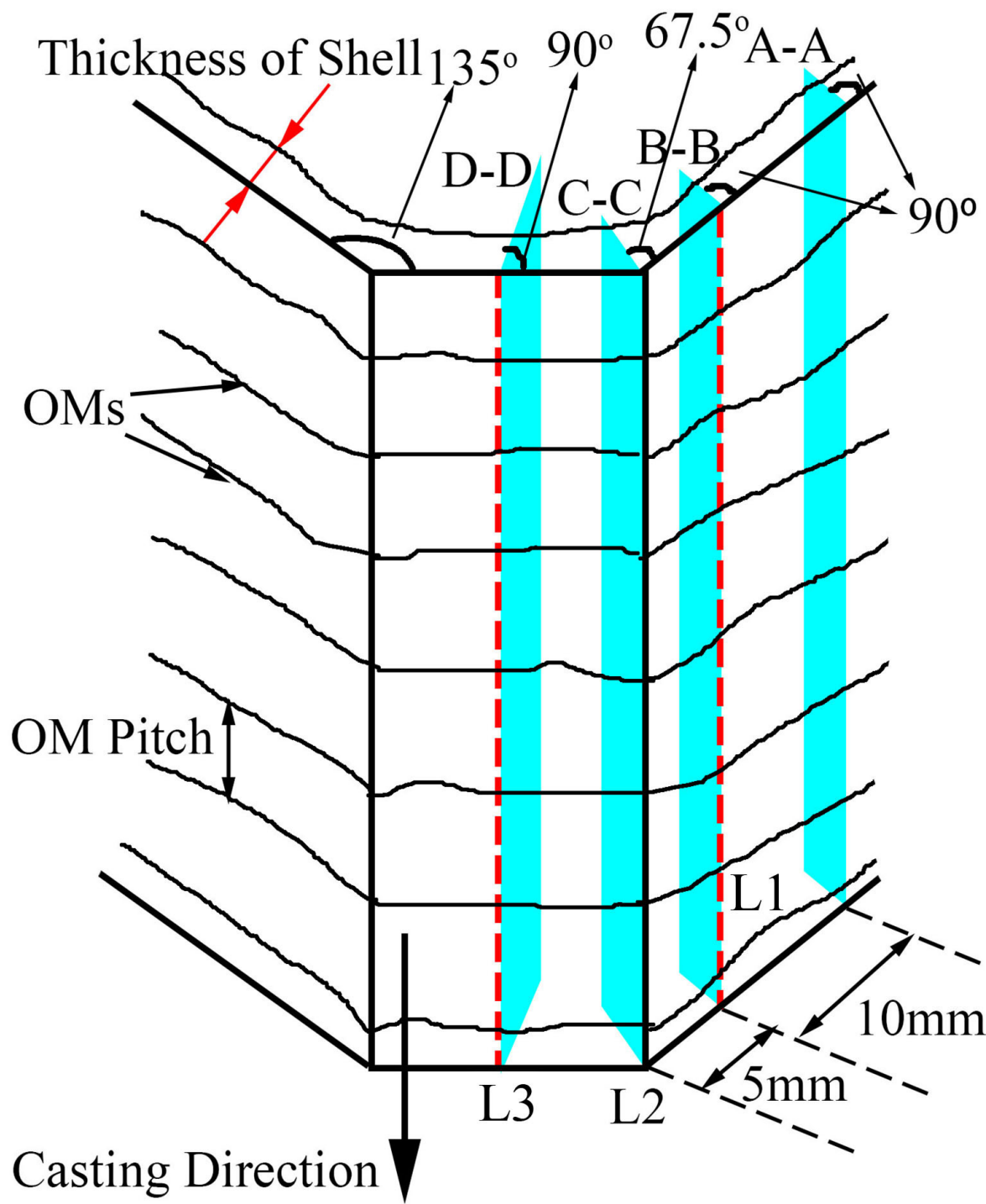
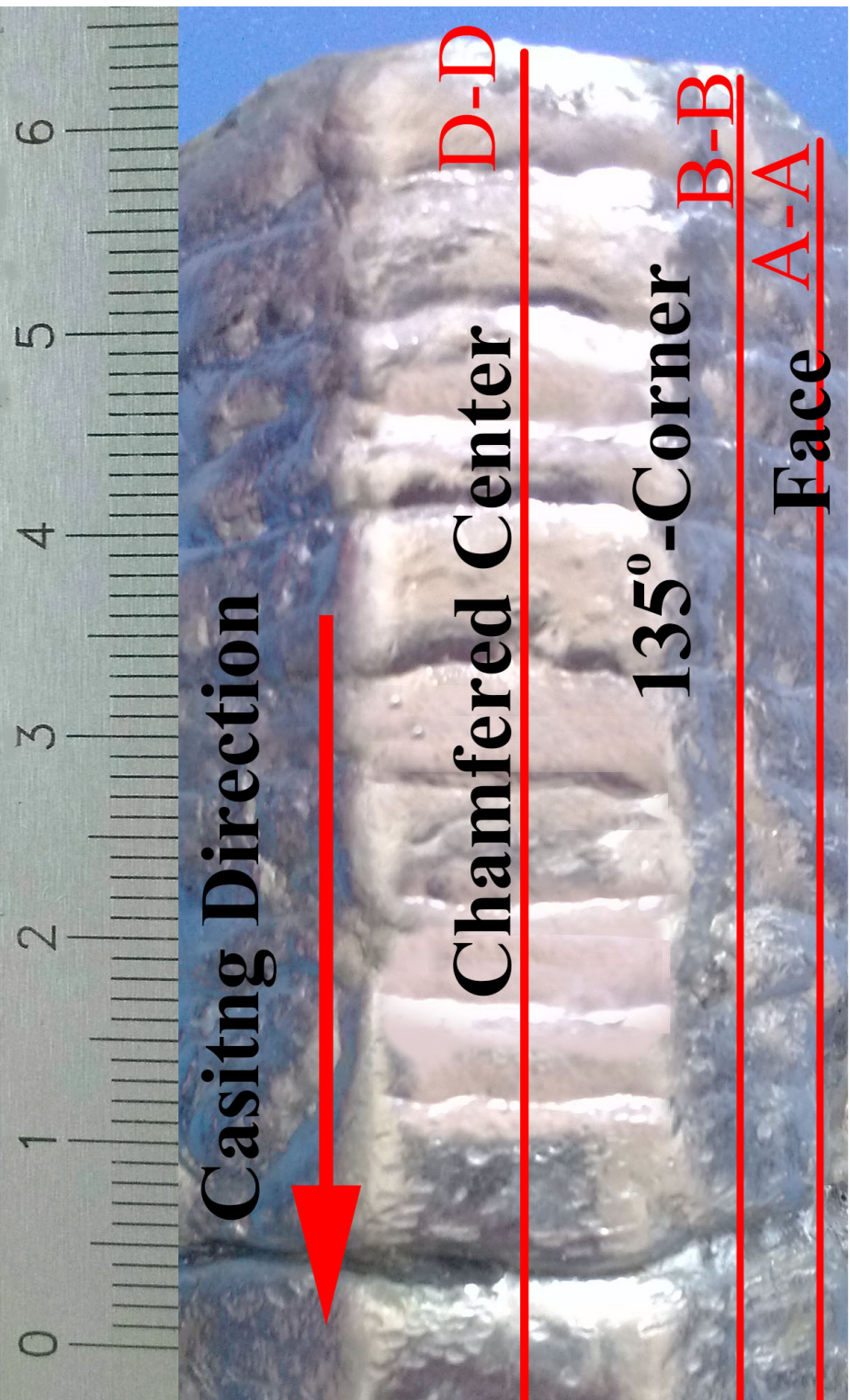


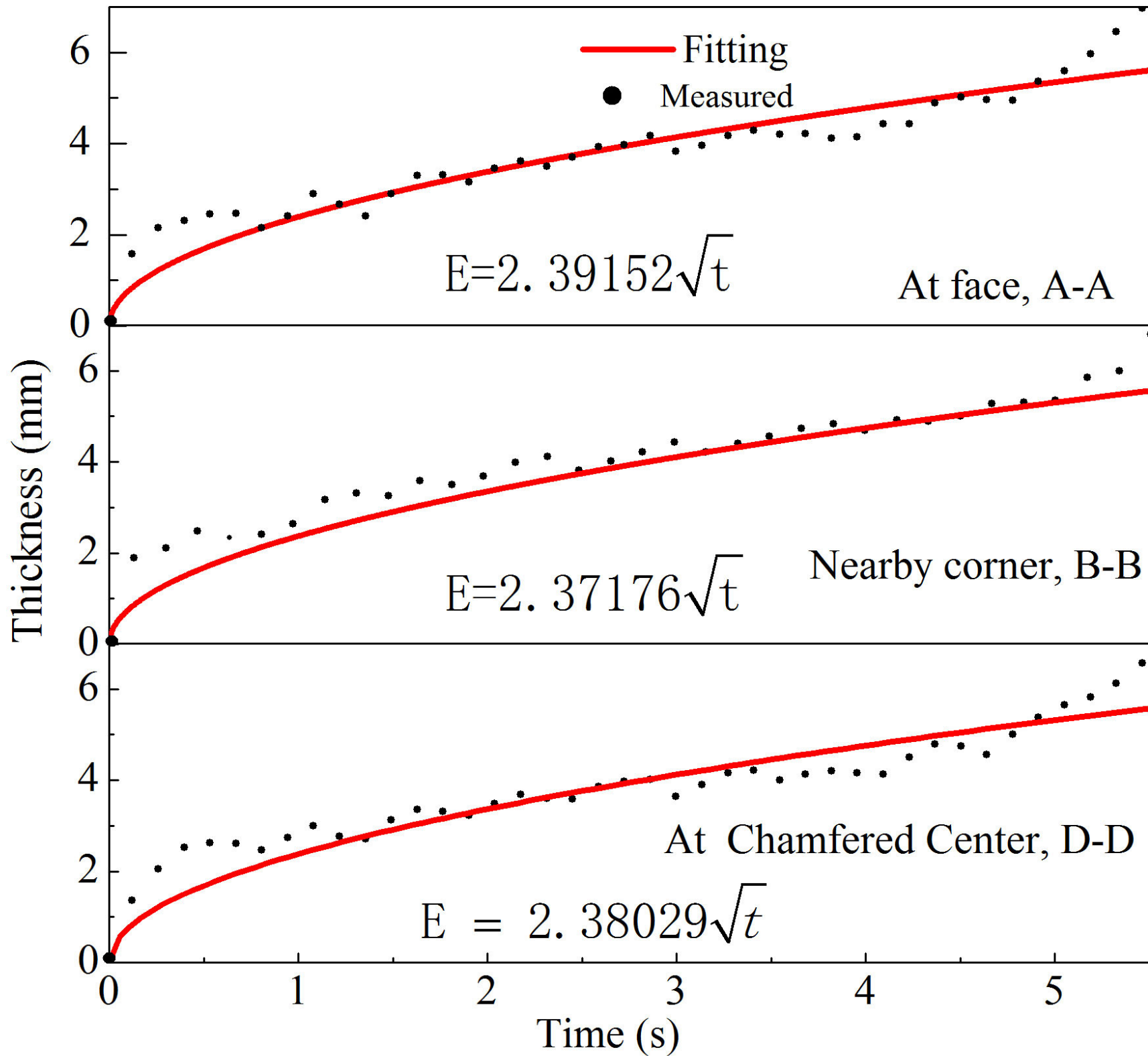
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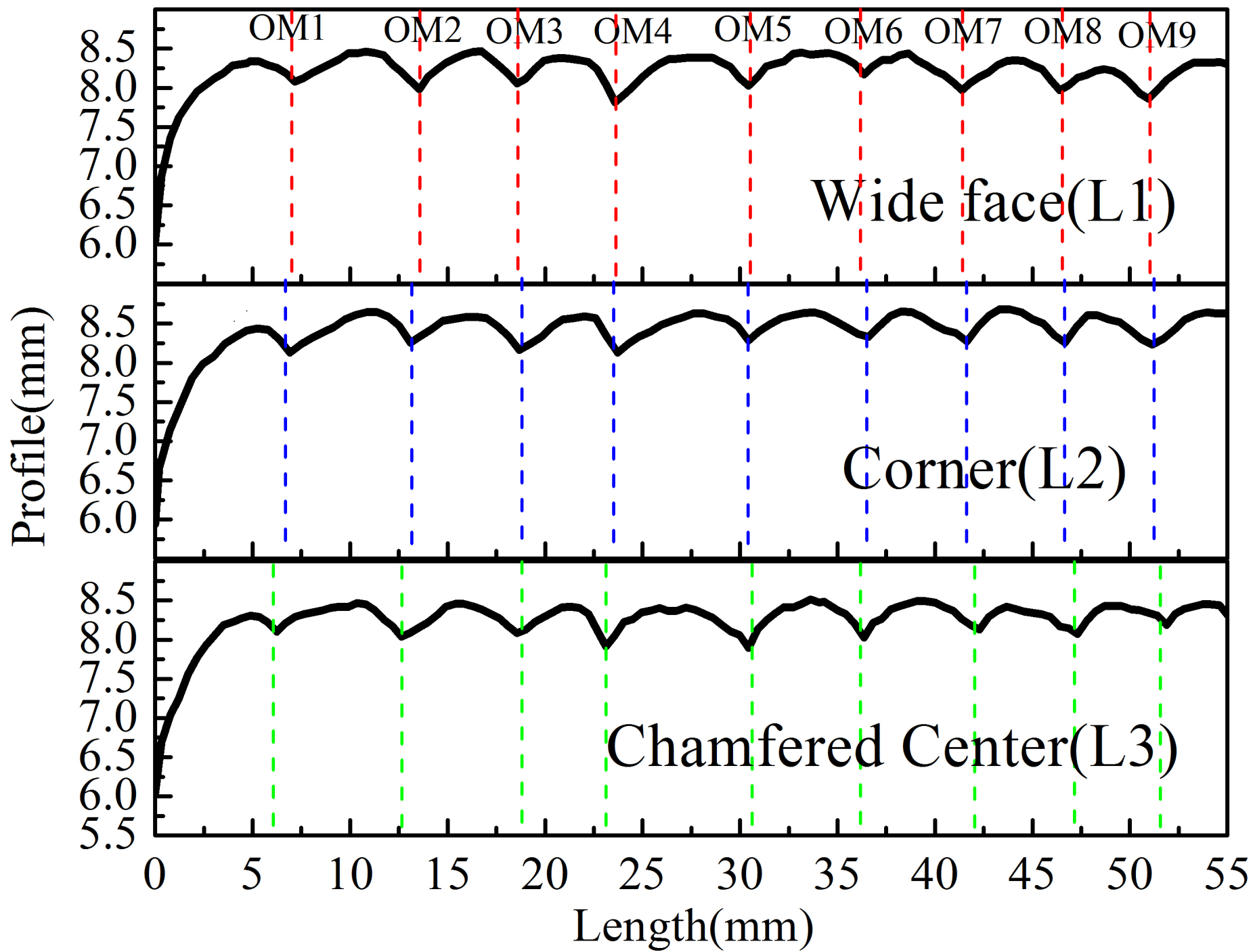


(b)









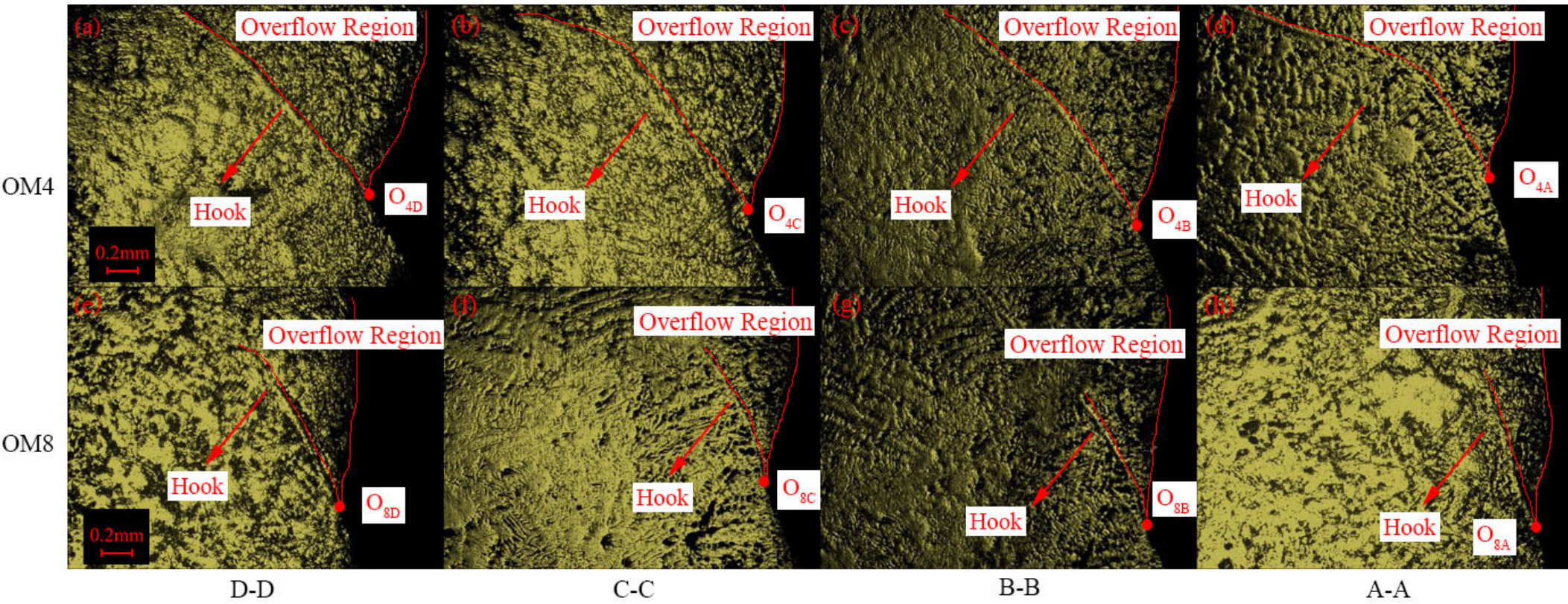


Table I. The Major Chemical Compositions of the Steel (Mass Percent %)

C	Si	Mn	P	S	Al	Ti	Nb
0.14	0.40	0.97	0.03	0.03	0.016	0.017	0.00047

Table II. The Major Chemical Compositions of the Mold Flux (Mass Percent %)

Basicity	CaO	SiO ₂	MgO	Al ₂ O ₃	Na ₂ O	B ₂ O ₃	Li ₂ O
1.15	41.72	36.28	2	4	8	6	2

Table III. Mold Oscillation Setting and Casting Conditions

Pouring Temperature[K(°C)]	Casting Speed(mm/s)	Frequency f (cpm)	Stroke(mm)	Temperature of Cooling Water[K(°C)]	NST(s)+PST(s)
1803(1530)	10	100(1.67Hz)	10	297(24)	0.26+0.34

Table IV. The Measured Pitch, Depth, and Height Difference for Each

Oscillation Mark at profile L1, L2 and L3

		OM1	OM2	OM3	OM4	OM5	OM6	OM7	OM8	OM9	Ave.	STD
Pitch (mm)	L1	—	6.58	5.13	4.91	6.91	5.65	5.22	5.13	4.60	5.52	0.77
	L2	—	6.45	5.70	4.66	6.95	6.07	5.13	5.02	4.60	5.57	0.81
	L3	—	6.57	6.18	4.39	7.43	5.55	5.96	5.03	4.36	5.68	1.00
Depth (mm)	L1	0.38	0.49	0.39	0.63	0.44	0.31	0.44	0.40	0.49	0.44	0.09
	L2	0.47	0.42	0.49	0.57	0.43	0.35	0.38	0.43	0.47	0.45	0.06
	L3	0.35	0.47	0.44	0.57	0.59	0.49	0.39	0.42	0.30	0.45	0.09
H_D (mm)	L1,L2	0.32	0.42	0.21	0.10	0.11	0.31	0.23	0.10	0.21	0.22	0.11
	L2,L3	0.62	0.61	0	0.42	0.21	0.31	0.42	0.5	0.32	0.38	0.19

*Where **Ave.** represents average value and **STD** represents standard deviation.

* H_D represents the height difference between two **OMs** roots of the same **OMs**.